

Network for Computational Nanotechnology (NCN)

Purdue, Norfolk State, Northwestern, MIT, Molecular Foundry, UC Berkeley, Univ. of Illinois, UTEP

Advanced Boundary Condition Method in Quantum Transport and its Application in Nanodevices

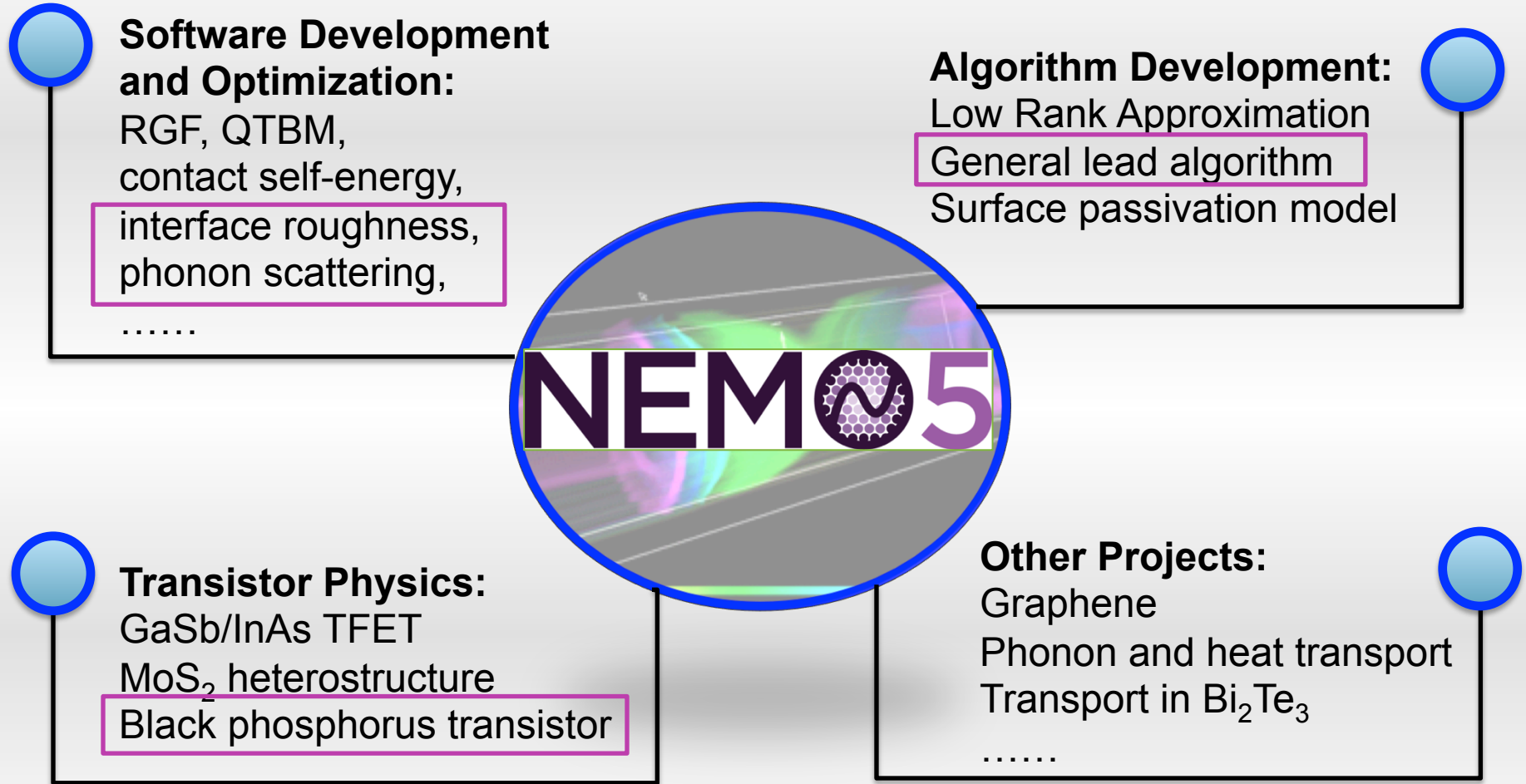
Yu He

Network for Computational Nanotechnology,
Purdue University

Defense Exam: Sep 22, 2015

PURDUE
UNIVERSITY

heyuyhe@gmail.com



Today's focus: transport study of
black phosphorus

Introduction

**Tight-
binding
model**

**Surface
roughness
scattering**

**Acoustic
phonon
scattering**

**Conclusion
& Outlook**

Introduction

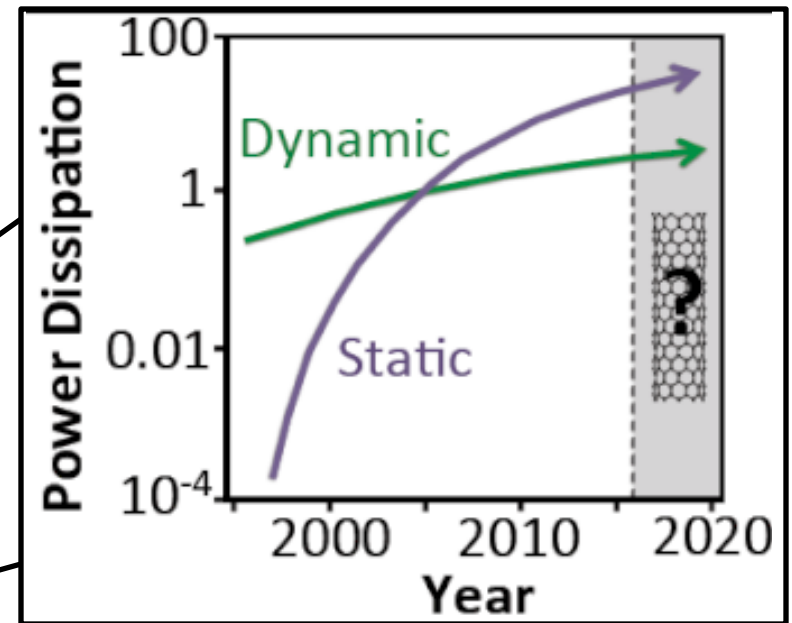
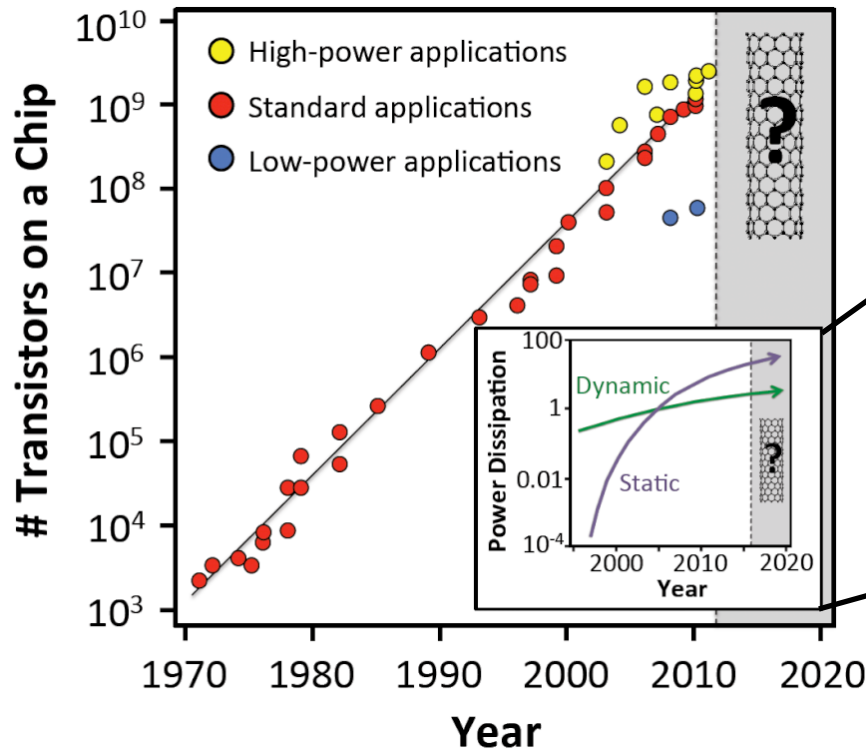
**Tight-
binding
model**

**Surface
roughness
scattering**

**Acoustic
phonon
scattering**

**Conclusion
& Outlook**

- ❖ Why do we study black phosphorus?
- ❖ Open questions in black phosphorus



http://www.eeweb.com/blog/aaron_franklin

Challenges:

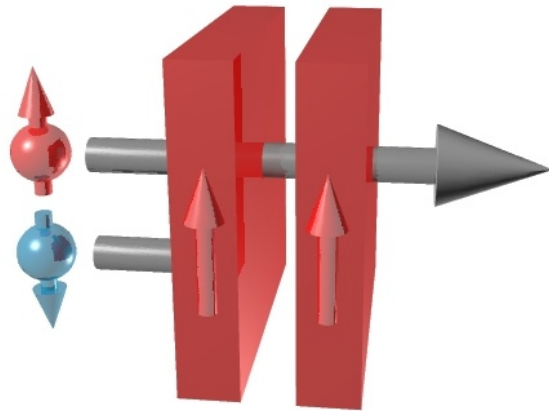
- Power consumption
- Leakage current
- Short channel effect
- Quantum effect

.....

Research efforts to solve these challenges

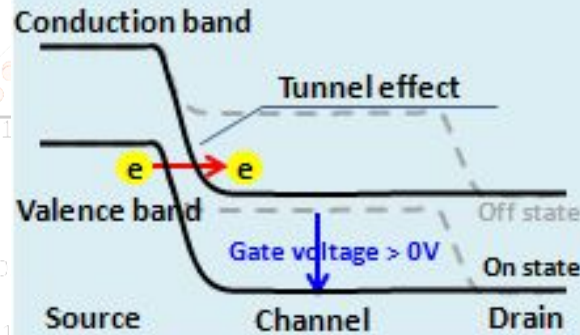
Transistor concept/design

Spintronics



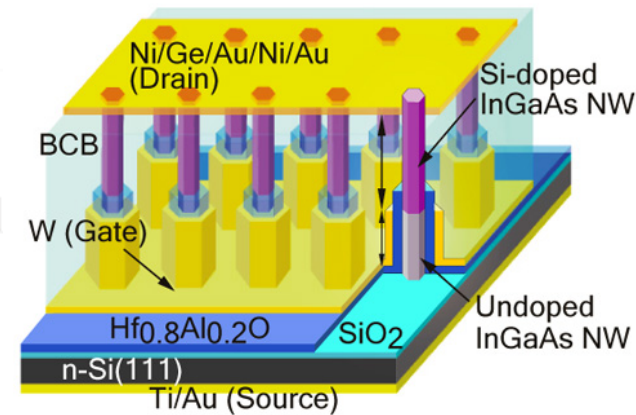
<http://bestlegalsteroidsarea212.rhcloud.com/tag/spintronics>

Operation mechanism: tunneling FET



<http://phys.org/news/2012-11-compact-tunnel-field-effect-transistors.html>

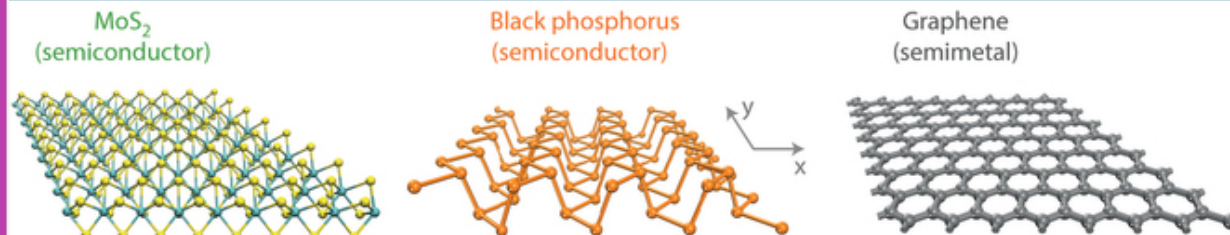
Geometry: vertical transistor



<http://physicsworld.com/cws/article/news/2012/aug/02/nanowires-give-vertical-transistors-a-boost>

Beyond traditional materials

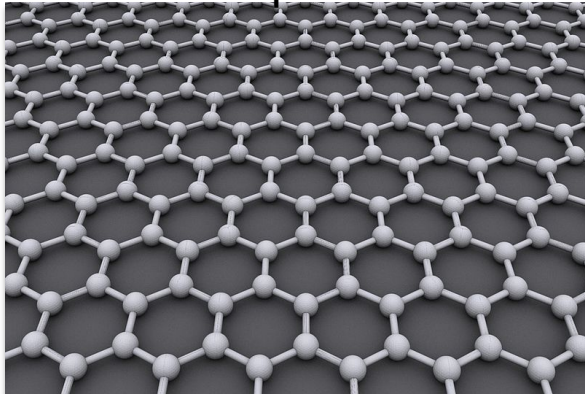
2D materials



http://www.nature.com/nphoton/journal/v8/n12/fig_tab/nphoton.2014.271_F1.html

2004

Graphene

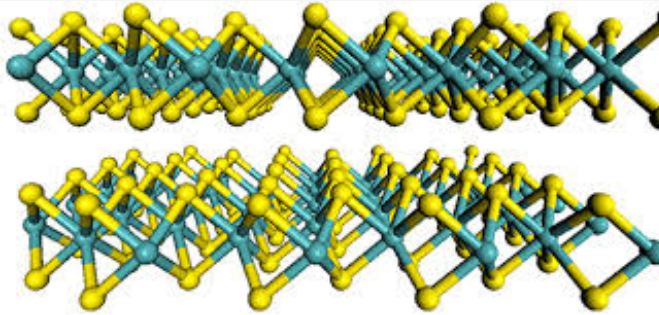


- 2D plane structure honeycomb shape
- High carrier mobility $\sim 10^5 \text{cm}^2/\text{Vs}$
- Semi-metal, no intrinsic band gap
- Nanoribbon, nanomesh

<https://en.wikipedia.org/wiki/Graphene>

2011

MoS₂

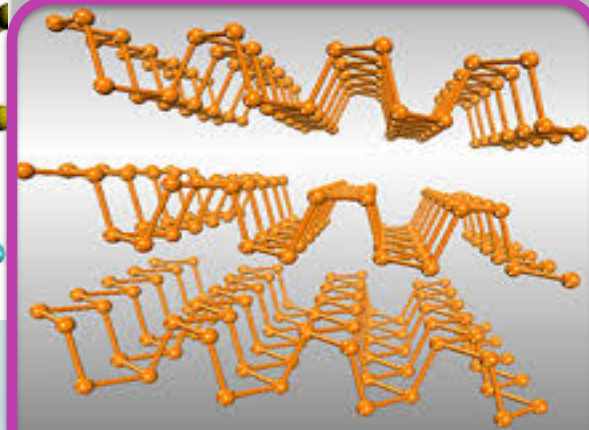


- TMDC (transition metal dichalcogenide)
- Stacked layer structure
- Intrinsic band gap
- Comparably low mobility $200\sim 400 \text{cm}^2/\text{Vs}$ \ll graphene

https://en.wikipedia.org/wiki/Molybdenum_disulfide

2014

Black phosphorus



- Stacked layer structure
- Intrinsic band gap
- Potential candidate in transistor application
- Many unknowns

L Li et al, Nature Nanotechnol. 9, 372 (2014).

Explore black phosphorus and its transport features

ARTICLES

PUBLISHED ONLINE: 2 MARCH 2014 | DOI: 10.1038/NNANO.2014.35

nature
nanotechnology

Black phosphorus field-effect transistors

Likai Li¹, Yijun Yu¹, Guo Jun Ye², Qingqin Ge¹, Xuedong Ou¹, Hua Wu¹, Donglai Feng¹, Xian Hui Chen^{2*} and Yuanbo Zhang^{1*}

We have succeeded in fabricating p-type FETs based on few-layer phosphorene. Our samples exhibit ambipolar behaviour with drain current modulation up to $\sim 10^5$, and a field-effect mobility

measured as a function of gate voltage for devices with different thicknesses: 10 nm (black solid line), 8 nm (red solid line) and 5 nm (green solid line), with field-effect mobility values of 984, 197 and 55 $\text{cm}^2 \text{V}^{-1} \text{s}^{-1}$, respectively. Field-effect mobilities were extracted from the line fit of the

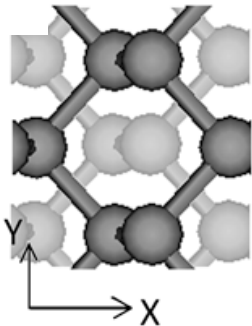
Promising performance motivates further exploration of black phosphorus

Why is black phosphorus good for transistor?

Intrinsic direct band gap

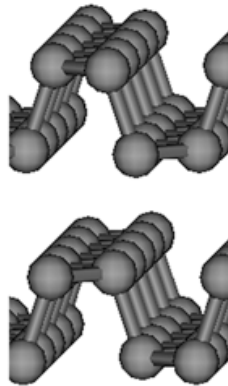
Black phosphorus structure

top view



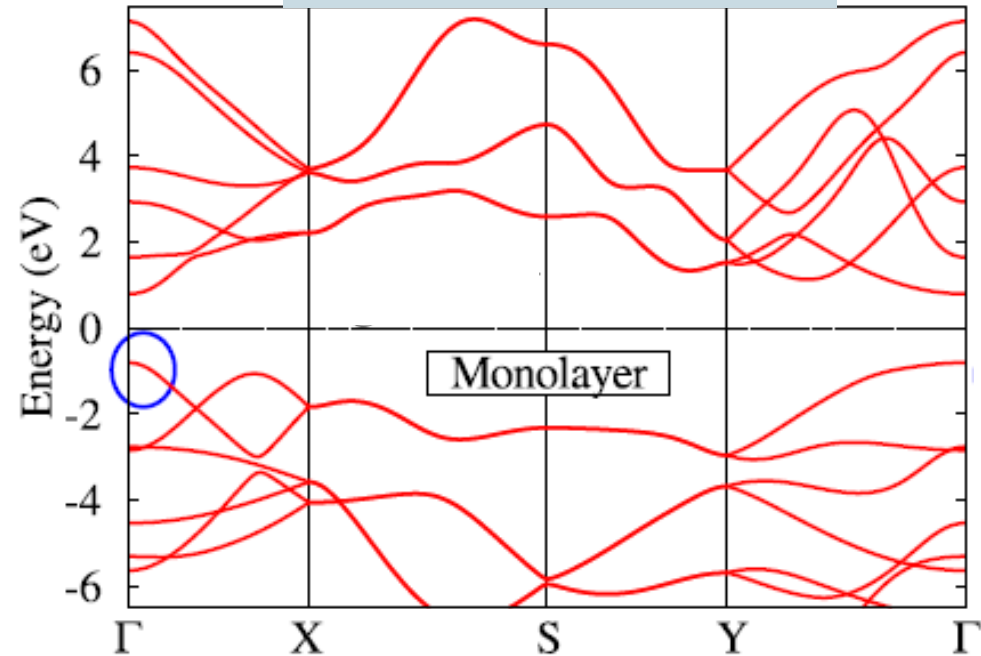
X: armchair
Y: zigzag

side view



- Stacked layer
- Honeycomb shape top view
- Different bond length

DFT-GW band structure



A Rudenko et al, Phys. Rev. B 89, 201408 (2014)

- Intrinsic direct $E_g \rightarrow$ superior to graphene
- Direct E_g thickness (layer) dependent \rightarrow optoelectronics
✓ monolayer $\sim 1.5\text{eV}$, bulk $\sim 0.3\text{eV}$



Semiconducting black phosphorus: synthesis, transport properties and electronic applications

Cite this: *Chem. Soc. Rev.*, 2015, 44, 2732

Han Liu, Yuchen Du, Yexin Deng and Peide D. Ye*

out to be an impurity dominated semiconductor. A band gap of 0.31 eV was estimated. Carrier mobilities extracted from the magnetoresistance coefficients gave the values of $2.7 \times 10^4 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ at 77 K and $1.5 \times 10^4 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ at 294 K, respectively, which are roughly one order of magnitude higher

Hall effect measurement for bulk black phosphorus

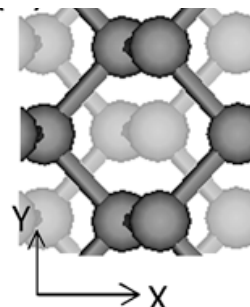
DFT calculation

$$\mu_{2D} = \frac{e\hbar^3 C_{2D}}{k_B T m_e^* m_d (E_1^i)^2}$$

$$\mu_{x,2D} \quad \mu_{y,2D}$$

$(10^3 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1})$

Hole mobility	0.64-0.70	10-26	1L ↓ 5L
	2.6-2.8	1.3-2.2	
	4.4-5.2	2.2-3.2	
	4.4-5.2	2.6-3.2	
	4.8-6.4	3.0-4.6	



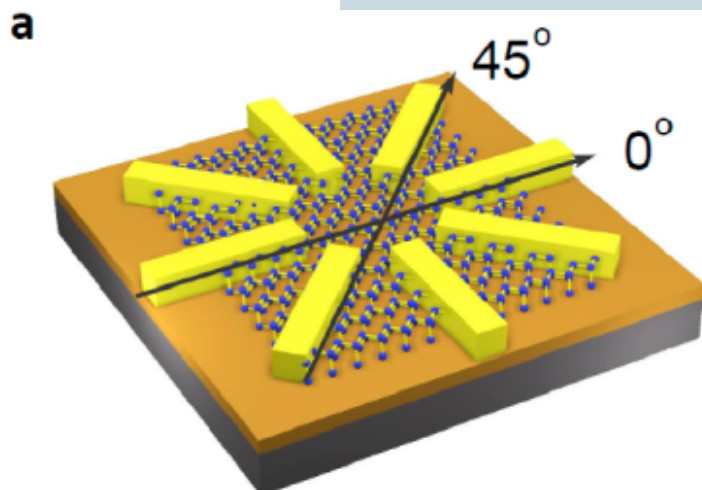
X: armchair
Y: zigzag

Hole mobility $\sim 10^4 \text{ cm}^2/\text{Vs}$

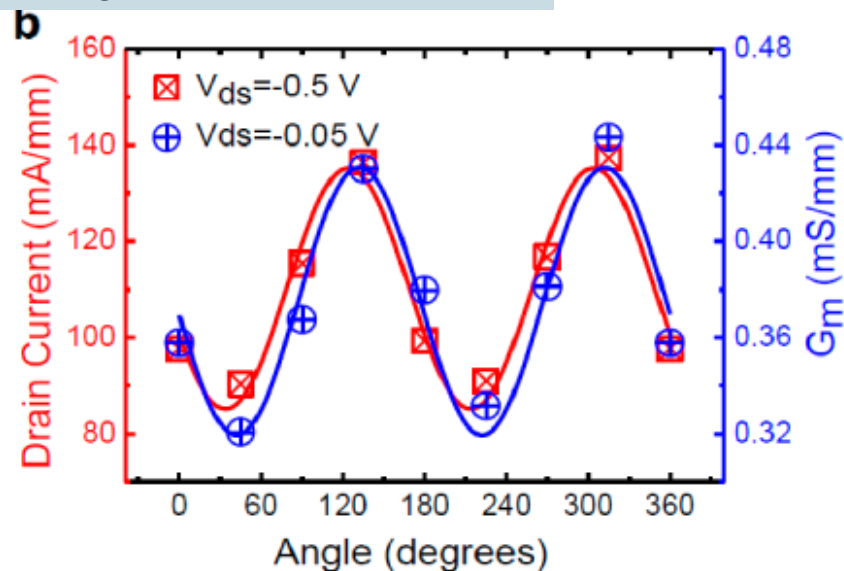
Why is black phosphorus good for transistor?

Anisotropic transport

Measured current along different directions



H Liu et al, ACSnano 8, 4033 (2014)

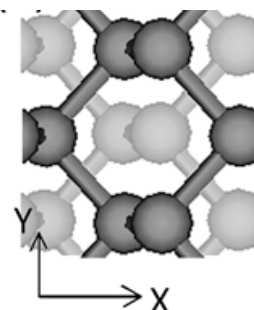


Cite this: *Chem. Soc. Rev.*, 2015, 44, 2732

Semiconducting black phosphorus: synthesis, transport properties and electronic applications

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demonstrated. In principle, we can design the transport along x-direction, which provides highest mobility, and channel width along y-direction, which has the highest density of states and where density of states remains the same determined by $(m_x m_y)^{1/2}$.⁵⁶ It is superior over other conventional III-V semiconductors, which has high electron mobility but low density of states. We can also design



Anisotropy: high mobility and DOS

- Many theoretical studies in dispersion level (electronic and phonon) using DFT
- One NEGF Ballistic transport
1L BP, n-type, 4-band tight binding

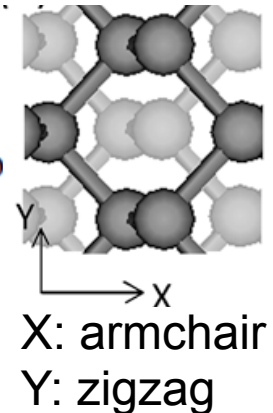
F Liu et al, IEEE Trans. Electron. Dev. 61, 3871 (2014)

IEEE TRANSACTIONS ON ELECTRON DEVICES, VOL. 61, NO. 11, NOVEMBER 2014

Ballistic Transport in Monolayer Black Phosphorus Transistors

Fei Liu, Yijiao Wang, Xiaoyan Liu, Jian Wang, and Hong Guo

The drain current density in AD can reach $3.1 \times 10^3 \mu\text{A}/\mu\text{m}$ at $V_G = 1.0$ V. The current in ZD, on the other hand, is lower by about $1.4 \times 10^3 \mu\text{A}/\mu\text{m}$, i.e., $\sim 45.2\%$ of that in AD. The



Measurement

H Liu et al, ACSnano 8, 4033 (2014).

channel length display a high on-current of $194 \text{ mA}/\text{mm}$,

Qualitatively reproduces anisotropic transport

Quantitatively differs from measurement

Measurement is far from ballistic
→ scattering exists

DFT calculation

$$\mu_{2D} = \frac{e\hbar^3 C_{2D}}{k_B T m_e^* m_d (E_1^i)^2}$$

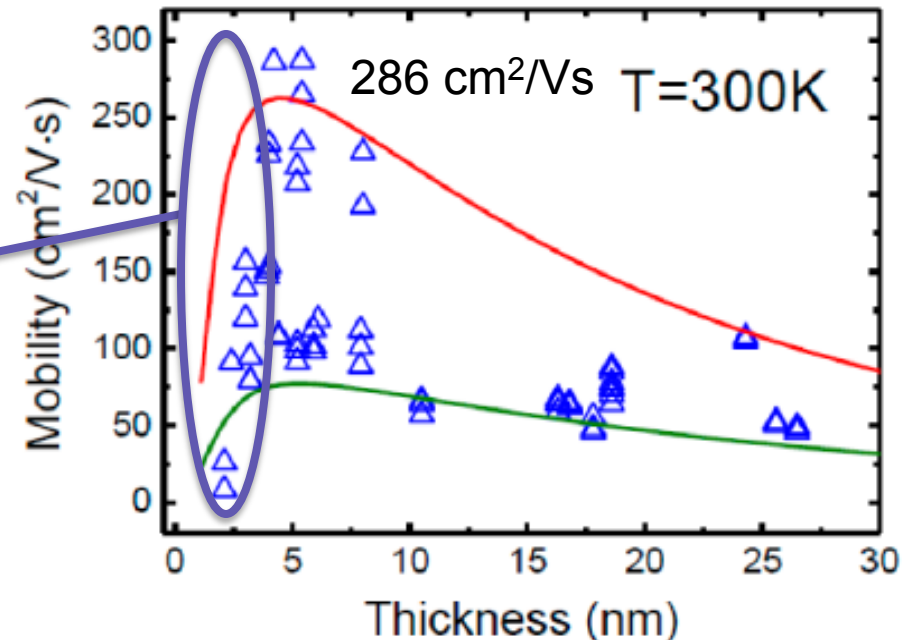
$$\mu_{x,2D} \quad \mu_{y,2D}$$

($10^3 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$)

Hole mobility	0.64-0.70	10-26	1L
	2.6-2.8	1.3-2.2	
	4.4-5.2	2.2-3.2	
	4.4-5.2	2.6-3.2	
	4.8-6.4	3.0-4.6	5L

J Qiao et al, Nature Comm. 5, 4475 (2014)

Measured hole mobility

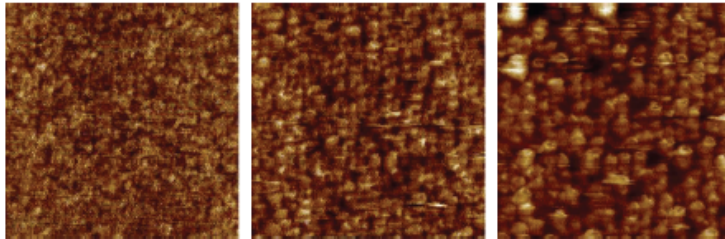


H Liu et al, ACSnano 8, 4033 (2014).

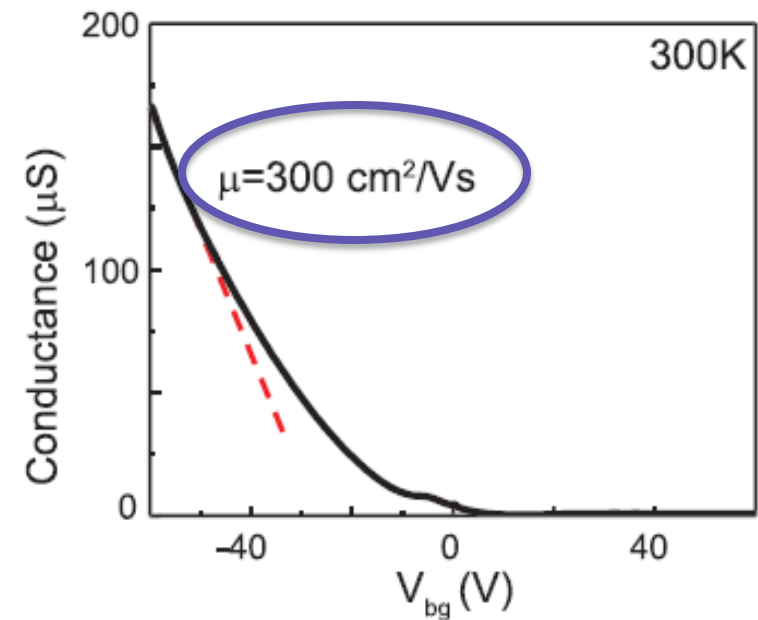
- Transport measured mobility $286 \text{ cm}^2/\text{Vs} \ll \text{expected } 10^4 \text{ cm}^2/\text{Vs} \rightarrow \text{scattering}$
- Possible scattering mechanism
 - Phonon, roughness, defect, impurity ...

Understand the dominating scattering mechanism through transport study is critical

Surface roughness in black phosphorus samples

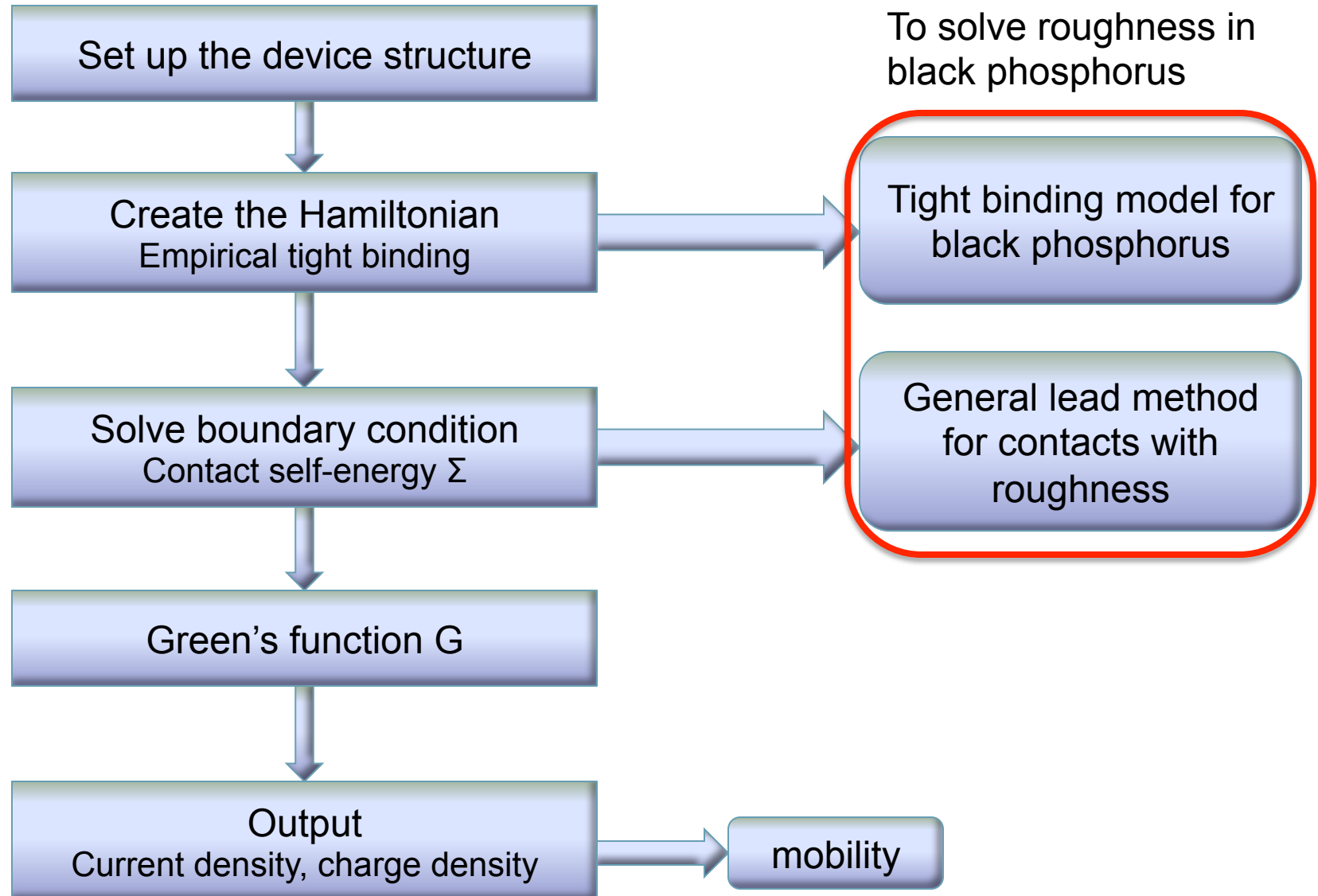


S Koenig et al, Appl. Phys. Letts. 104, 103106 (2014)



- Surface roughness observed in experiment
- Measured mobility from rough sample is $\sim 300 \text{ cm}^2/\text{Vs}$
- Does roughness scattering dominate?

Understand the impact of roughness scattering through transport study



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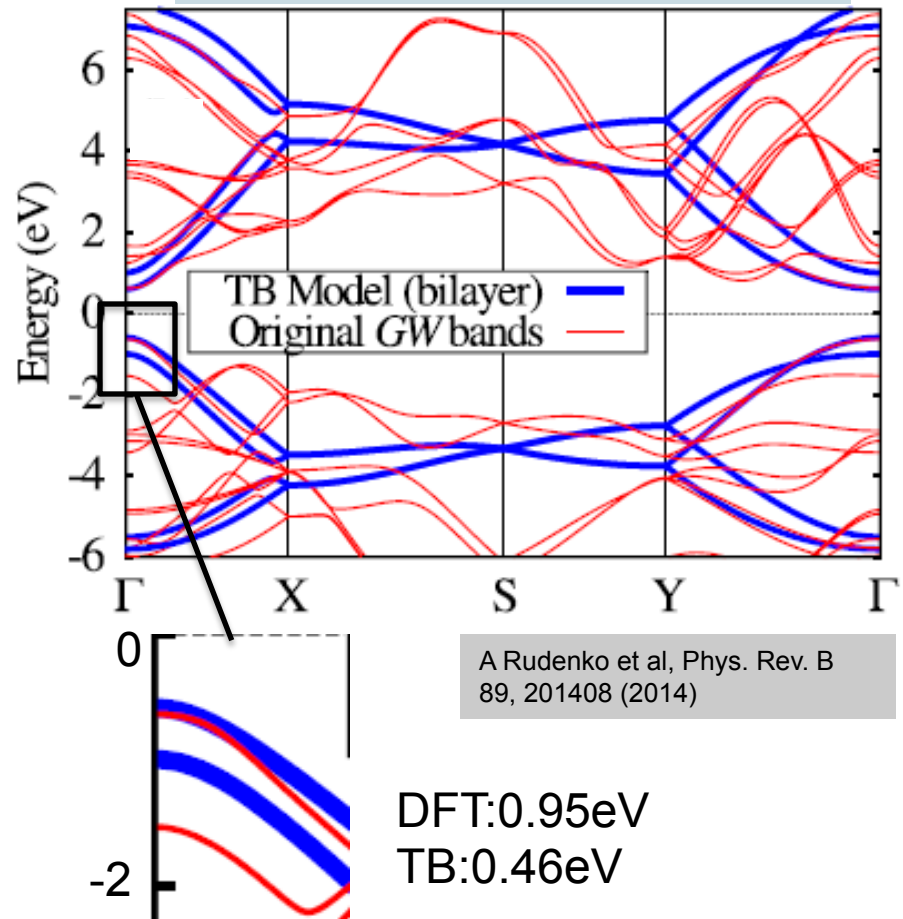
Acoustic
phonon
scattering

Conclusion
& Outlook

- ❖ Problem of existing 4-band model
- ❖ 10-band model and parameterization

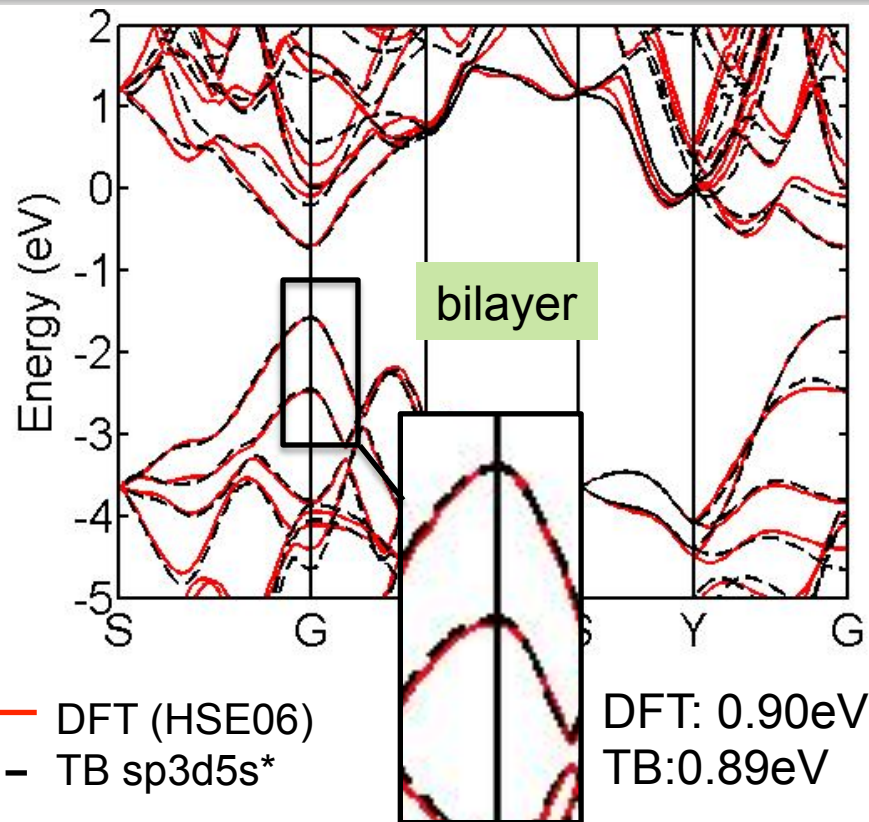
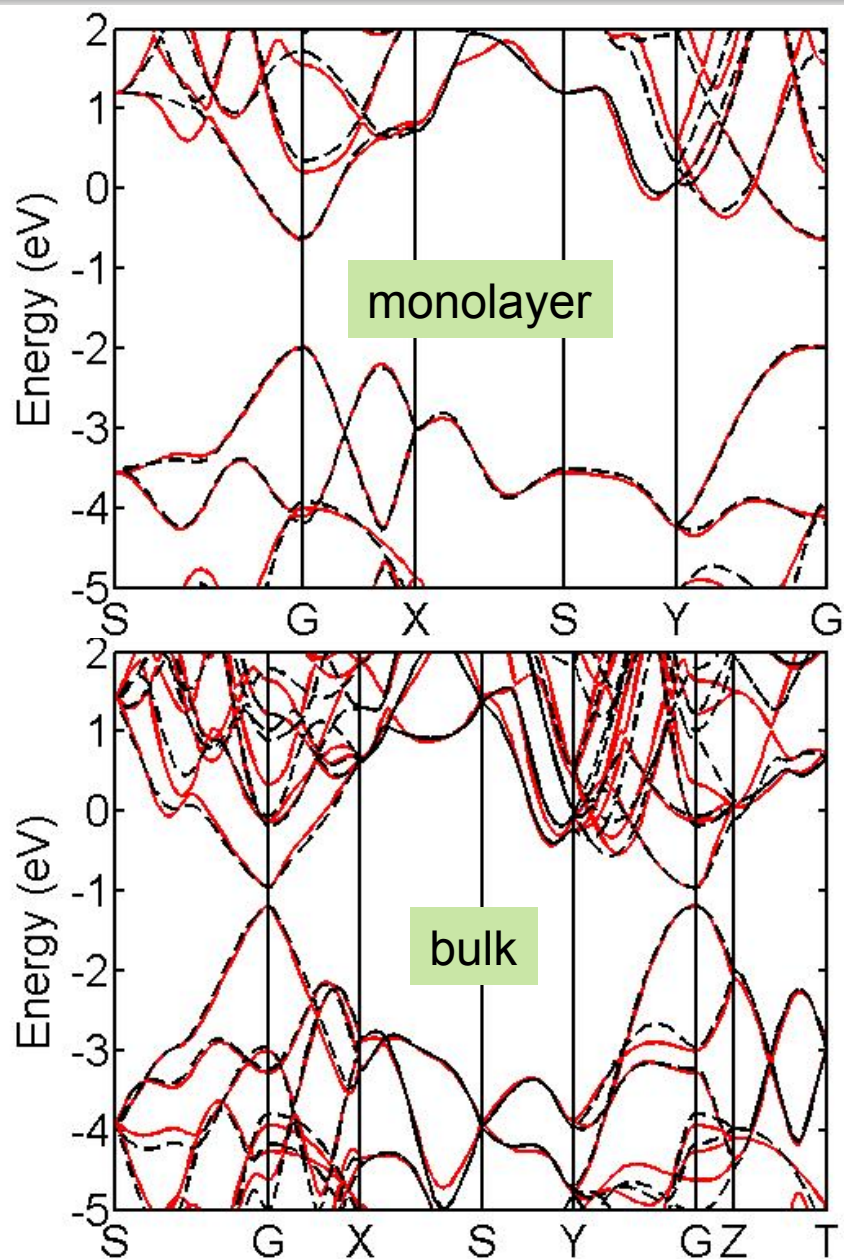
- 4-band TB underestimates E_v splitting by ~50%
- DFT splitting smaller in more layers
→ 3L: 0.4 eV; 4L: 0.2 eV;
4-band model close to degenerate
- Would change hole distribution
- Worse if scattering exists

Band structure for bilayer (2L) black phosphorus



Better TB model is required for quantitative simulation

Ten-band (sp^3d5s^*) TB model



- DFT HSE06 band structure is nicely reproduced with 10-band TB.
- Band splitting is well captured.
- Generic model for arbitrary layers.

Introduction

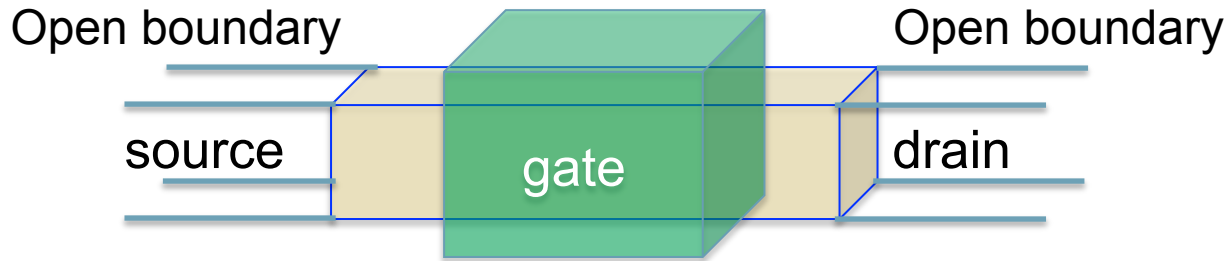
Tight-
binding
model

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Conclusion
& Outlook

- ❖ Challenges in solving rough contacts
- ❖ New algorithm: general lead method
- ❖ Benchmark and application
- ❖ General lead method applied to roughness in black phosphorus



Device:

- Where the critical physics do not change
e.g. for a homogeneous device structure, the transmission is length independent in ballistic calculation

Contact:

- Serve as the boundary condition of the device
- Have specific DOS and carrier distribution
- Semi-infinite extension of the device at its boundary
→ homogeneous (periodic) , reserve the critical physics of the device

Critical physics of the device should be reserved with proper contact treatment

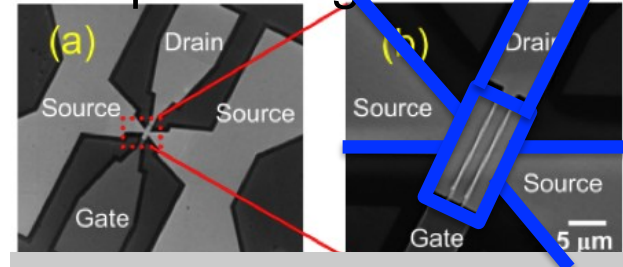
Challenges in the existing contact treatment only solve homogeneous (periodic) contacts

homogeneous periodic contacts.

Common contact
methods:
Sancho Rubio,
transfer matrix



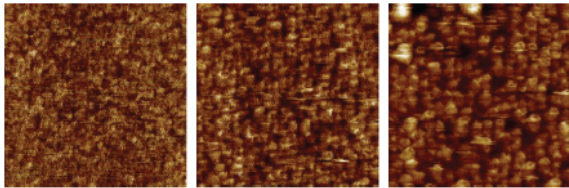
Non-periodic geometries



http://www.electroiq.com/articles/sst/2010/12/iedm-reflections_.html

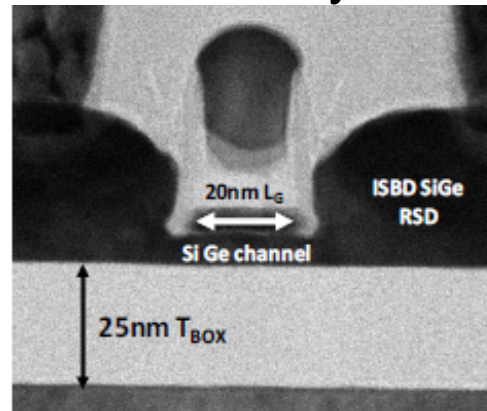
But in the real
world...

Roughness



S. Koenig et al, Appl. Phys. Lett, Vol. 104, pp. 103106, 2014

Random alloy



Q. Liu, et al, IEDM p.229 2013

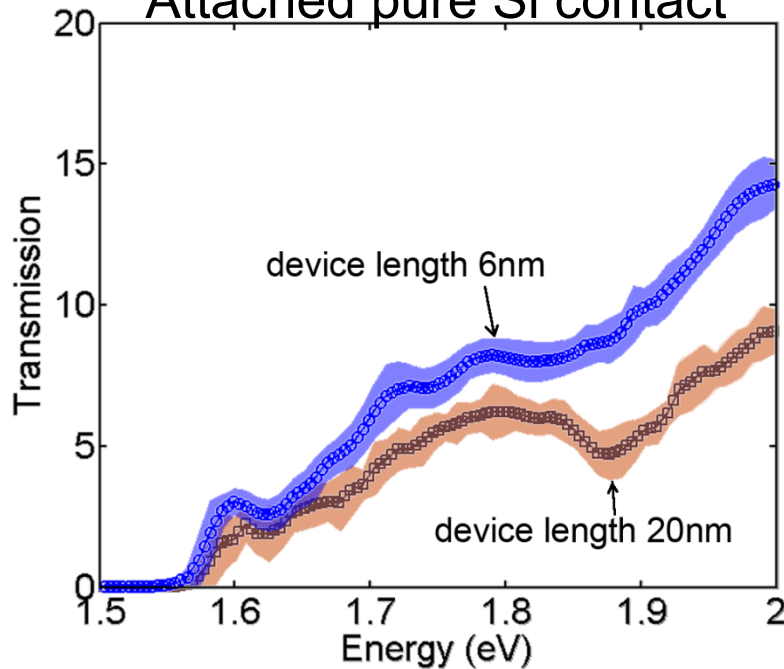
With disorder in the
device, homogeneous
(periodic) contact
cannot reserve the
device physics

Alloyed device with periodic contacts

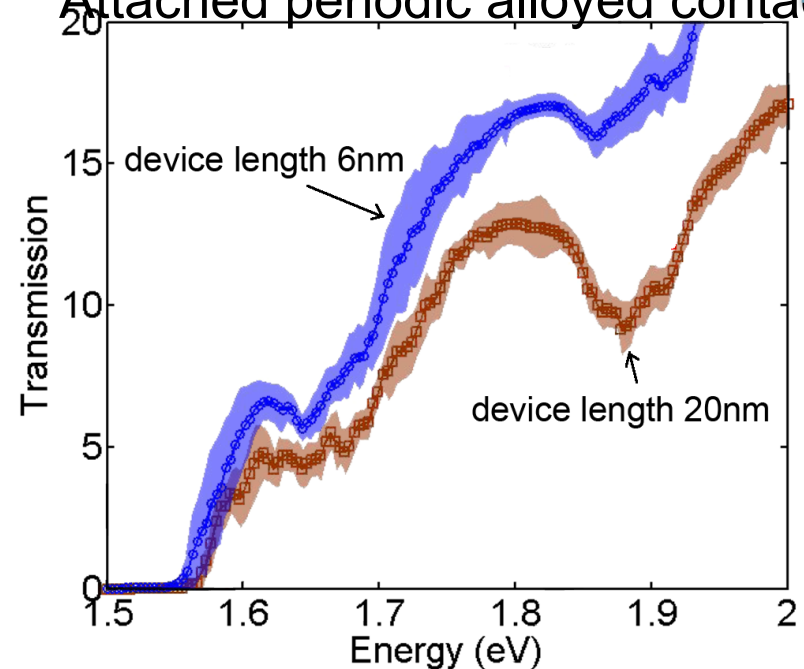
3nm diameter $\text{Si}_{0.5}\text{Ge}_{0.5}$ nanowire



Attached pure Si contact



Attached periodic alloyed contact



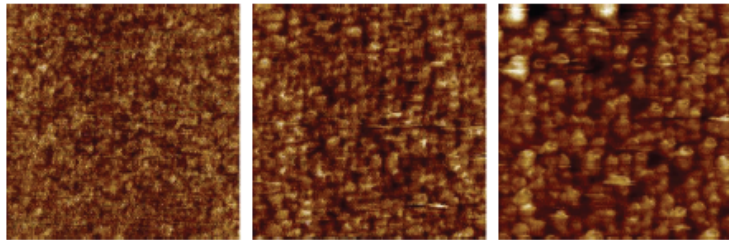
With periodic contacts, alloy device's transmission in ballistic calculation is
 1) length dependent, and 2) relied on contact materials
 → DOS mismatch between periodic contacts and alloy device

- Critical device physics change with contact
- Possible solution: have disorder contact treatment

Solve NEGF with surface roughness

roughness exists in both device and contacts

Roughness in experiment



S Koenig et al, Appl. Phys. Letts. 104, 103106 (2014)

Roughness in simulation

- Randomly distribute atoms at the surfaces
- Distribution follows autocovariance function

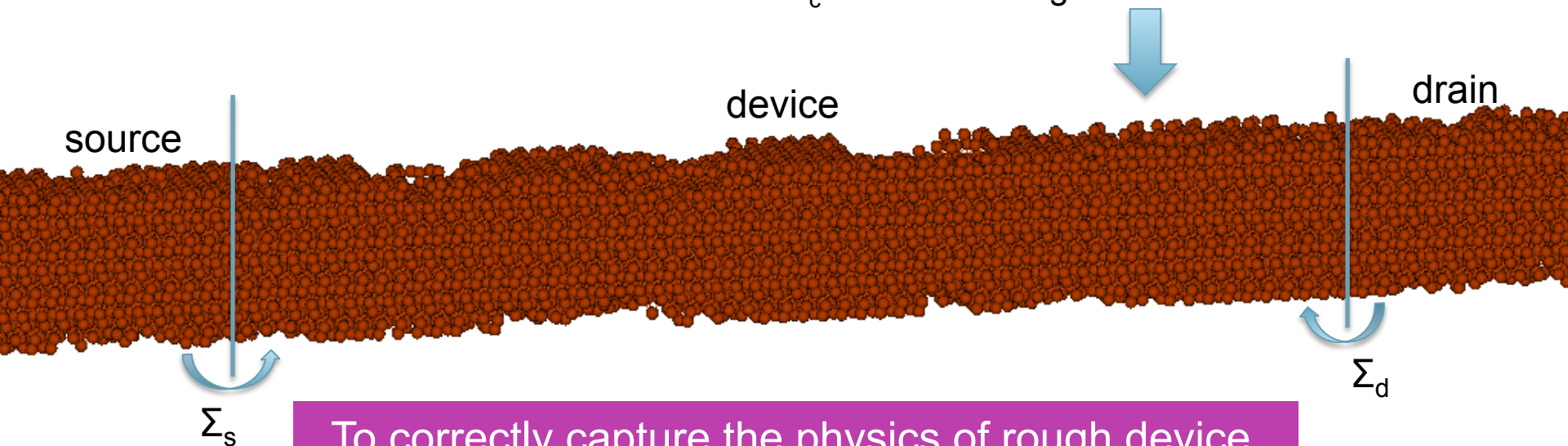
$$ACVF_{ij} = \Delta^2 \exp(-\sqrt{2} |r_i - r_j| / L_c)$$

Kim et al, IEEE Trans. Elect. Dev. 58, 1371 (2011).

r_i, r_j the coordinates of surface atoms i, j

Δ root mean square of roughness

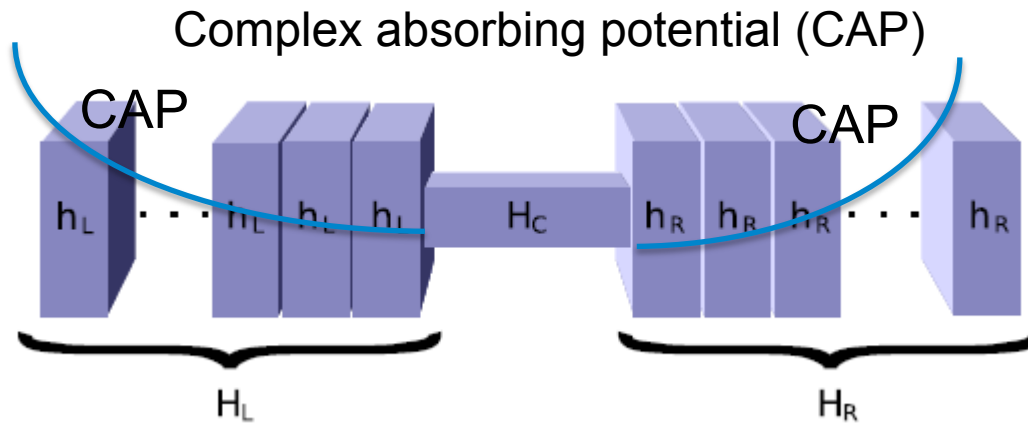
L_c correlation length



To correctly capture the physics of rough device, contact treatment with roughness is needed.

Problem:

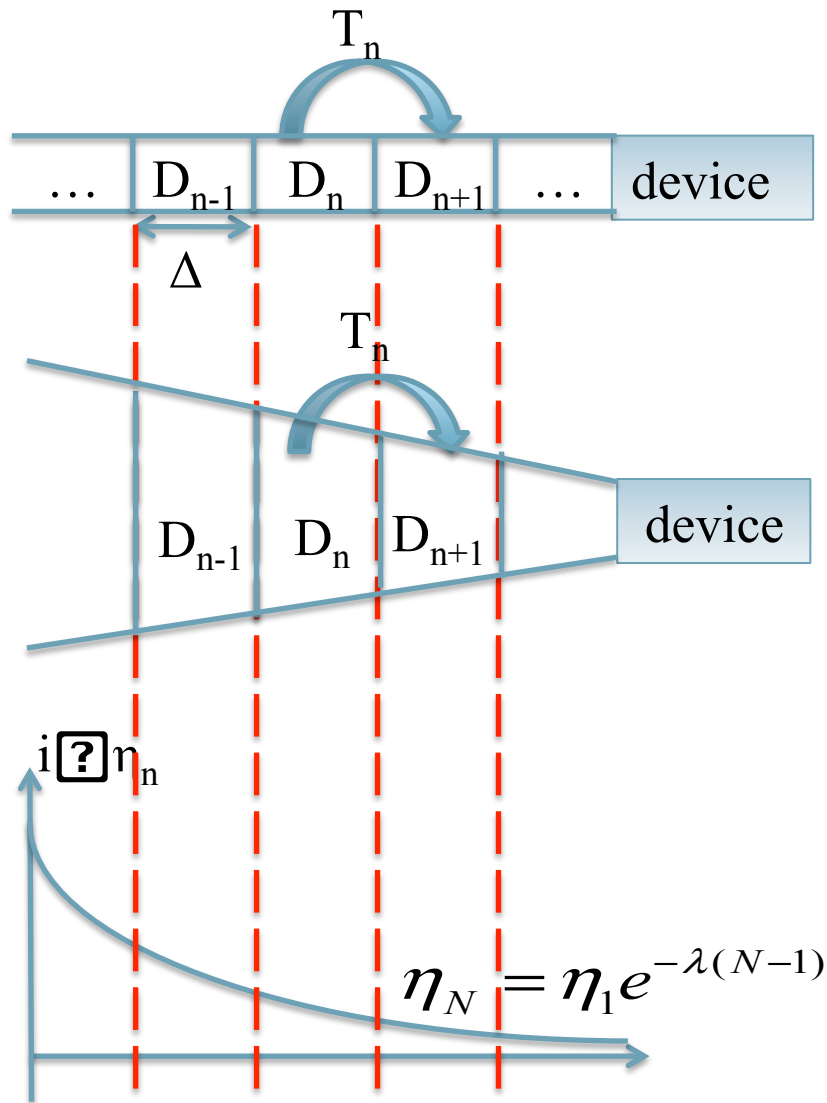
- No exact solution for semi-infinite systems if not assume periodicity;
- Approximate solution
 - ✓ Physically correct
 - ✓ Numerically solvable for arbitrary contact structures



J. Driscoll et al, Phys. Rev. B.
Vol. 78, pp. 245118, 2008

Idea: extend complex absorbing potential (CAP) method

- **Non-periodic contact** : Hamiltonian for explicit contact segments
- **CAP serves as scattering** : physical assumption of contacts
- **Efficient, memory thin** : converge within finite iterations



Known: direct iterative method

$$\Sigma_n = T_n \boxed{?} g_{n-1} \boxed{?} T_n$$

$$g_n = (D_n - \Sigma_n)^{-1}$$

convergence issues: initial guess propagates ballistically
($>10^3$ iterations)

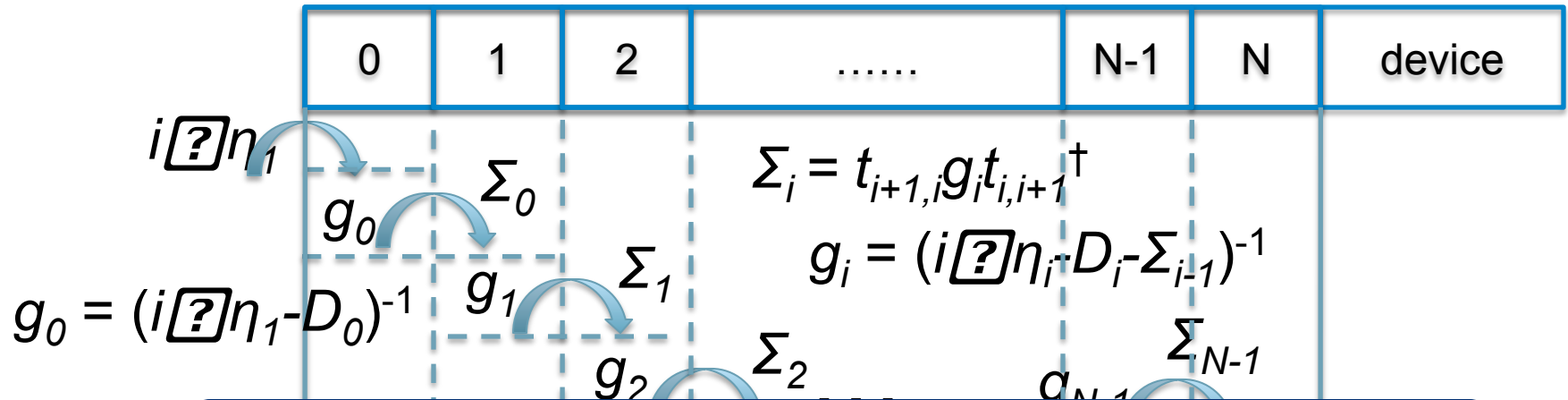
General lead approach: CAP i $\boxed{?}$ η

$$\Sigma_n = T_n \boxed{?} g_{n-1} \boxed{?} T_n^\dagger$$

$$g_n = (D_n + i \boxed{?} \eta_n - \Sigma_n)^{-1}$$

Basic rules to choose η :

- Big initial value \rightarrow blurs interference far away
- Ballistic close to the interface \rightarrow matches device DOS
- Fast convergence (within 200 iterations)

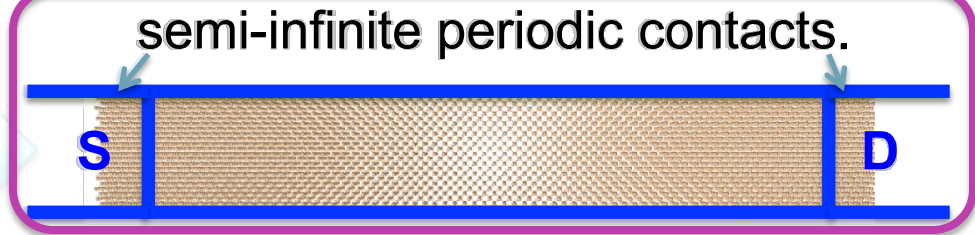


Advantage:

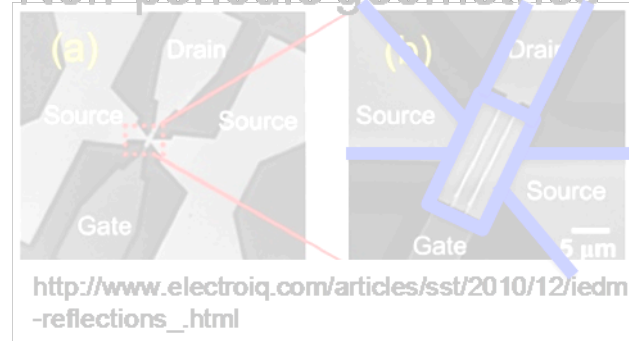
- ✓ Explicitly include the actual contact segments
- ✓ Memory thin → promising for realistic device simulation

0						
1						
2						
N-1						
N						

Common self-energy methods
Sancho Rubio,
transfer matrix

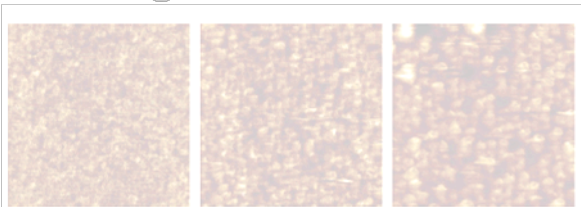


Non-periodic geometries



But in the real world...

Roughness



S. Koenig et al, Appl. Phys. Lett, Vol. 104, pp. 103106, 2014

Random alloy



Q. Liu, et al, IEDM p.229 2013

- Periodic assumption contradicts realistic contacts
- Method applicable for non-periodic contacts is required

Example:

Regular 3x3x20nm Si nanowire in $sp^3d^5s^*$ tight binding
Pure Si contact

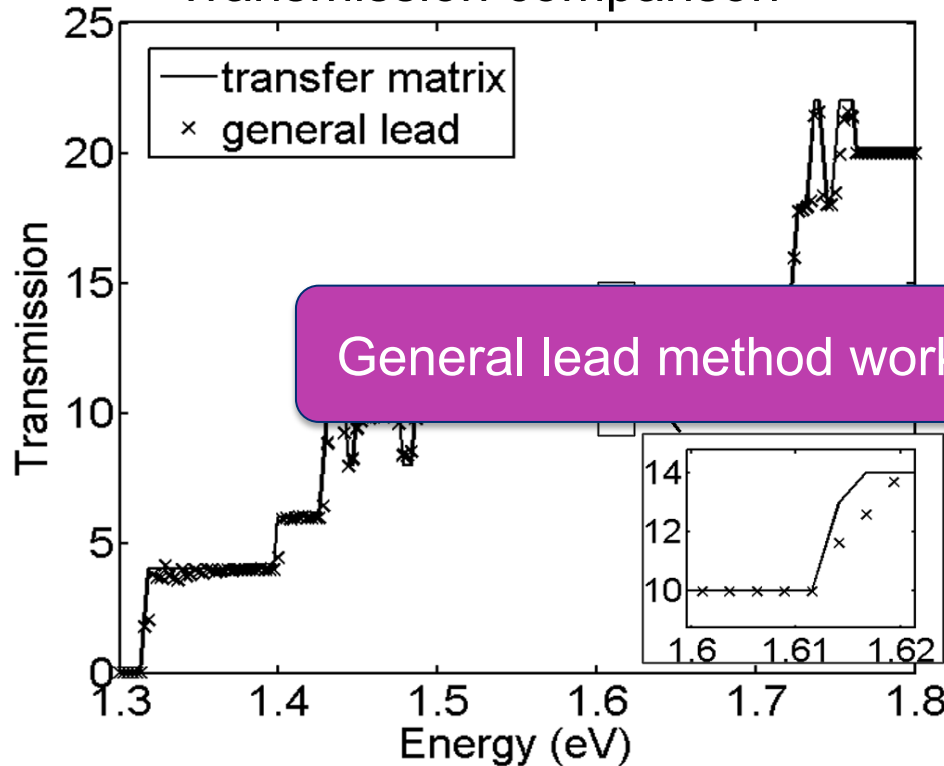
Damping details:

$$\eta_1 = -0.5 \text{ eV},$$

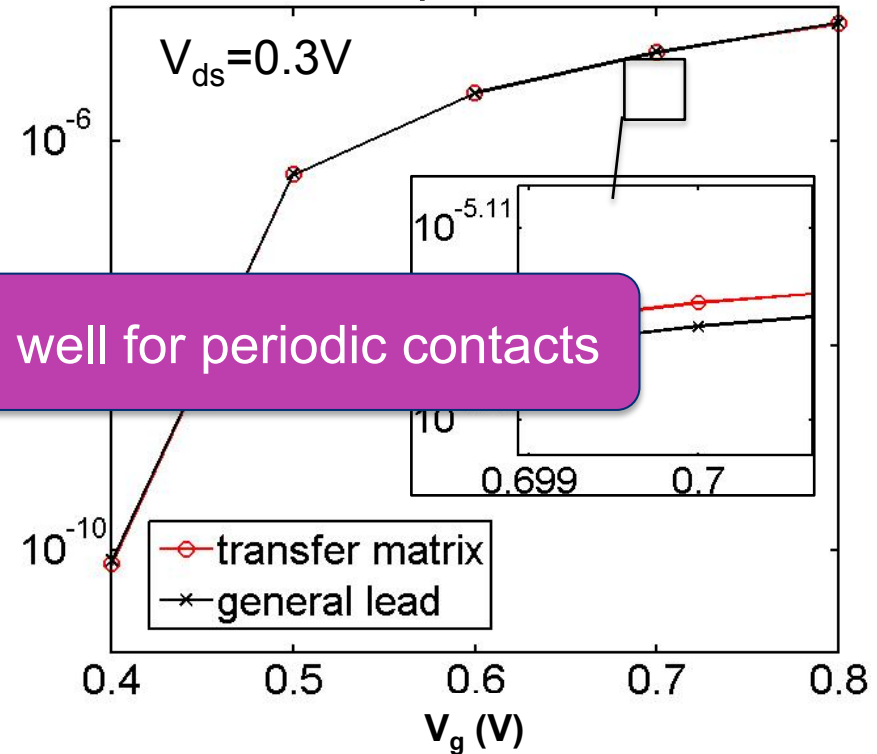
$$\eta_i = \eta_1 \exp(-\lambda |i|)$$

$$\lambda = 0.1, i = 0 \dots 155$$

Transmission comparison



IV comparison



General lead method works well for periodic contacts

Timing for Σ solution
Transfer matrix: 9.6s
General lead: 50.8s

- Transmission agrees with common method
- Deviations observed only close to van Hove singularities
- I-V curve agrees well

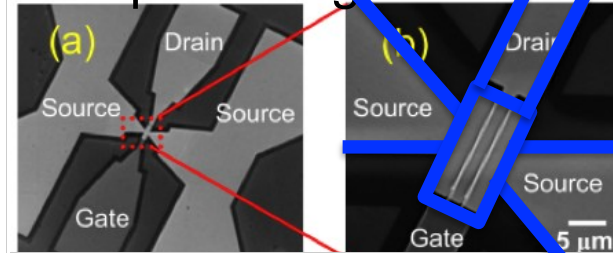
Challenges in existing self-energy methods

only solve periodic contacts
semi-infinite periodic contacts.

Common self-energy methods
Sancho Rubio,
transfer matrix



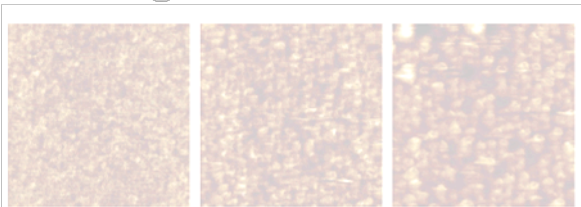
Non-periodic geometries



http://www.electroiq.com/articles/sst/2010/12/iedm-reflections_.html

But in the real world...

Roughness



S. Koenig et al, Appl. Phys. Lett, Vol. 104, pp. 103106, 2014

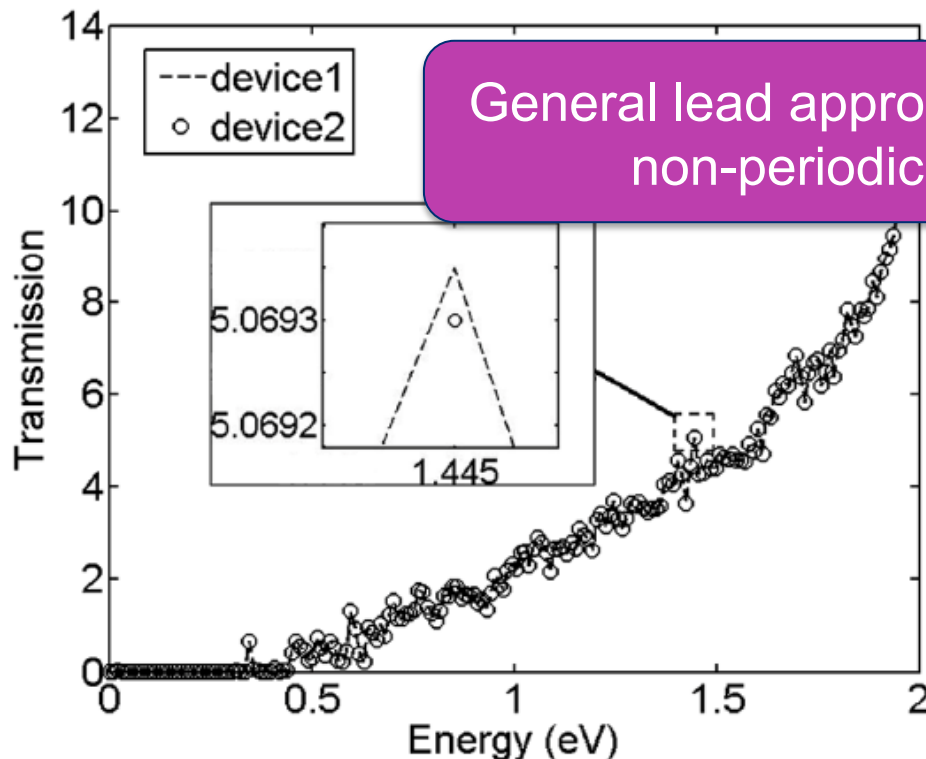
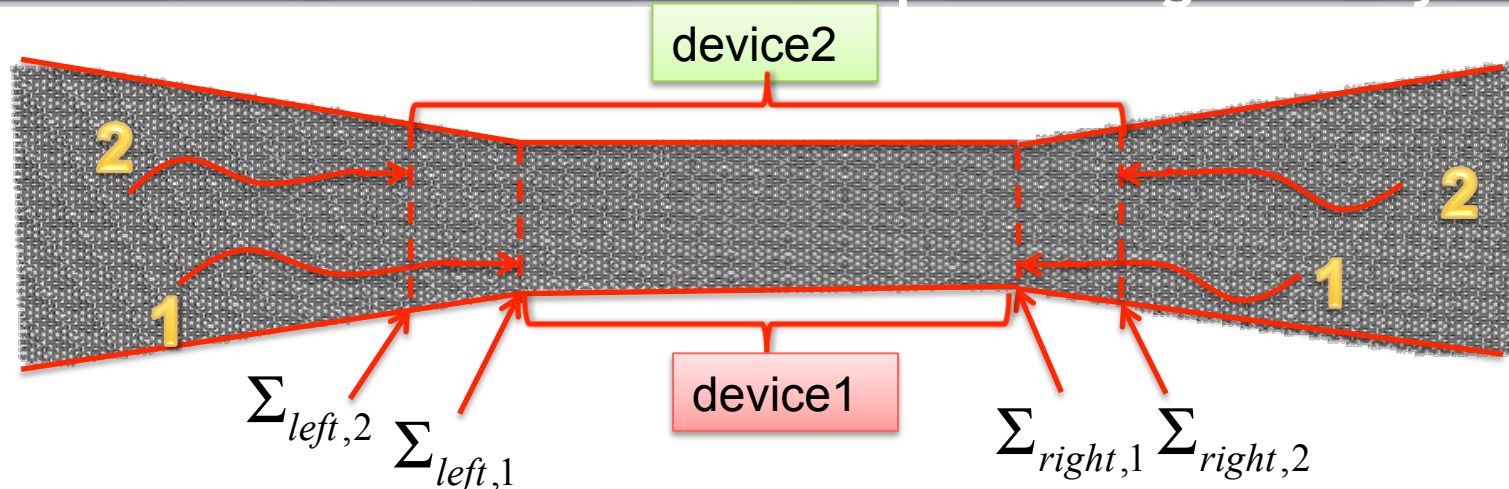
Random alloy



Q. Liu, et al, IEDM p.229 2013

- Periodic assumption contradicts realistic contacts
- Method applicable for non-periodic contacts is required

Example:
20x10nm GNR
with trumpet
shaped contacts,
Electrons in PD
tight binding



General lead approach is able to represent non-periodic contact geometries

Verification of irregular lead

device 2 are numerical different but physically equivalent

➤ Equilibrium results of device 1 and 2 have to agree

✓ Identical transmission for device 1 and device 2

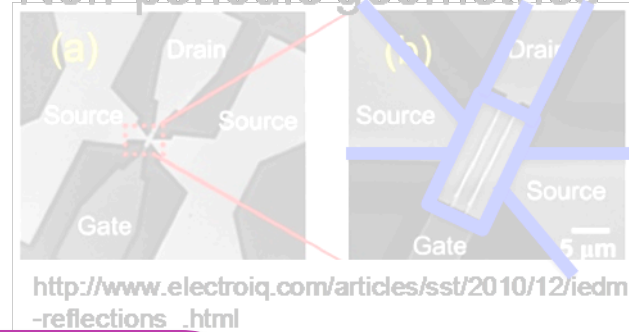
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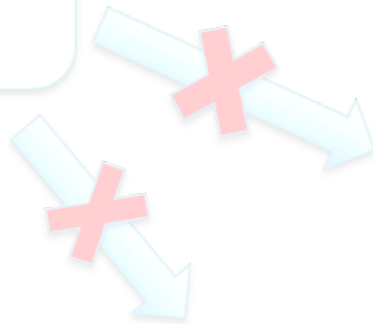
Common self-energy methods
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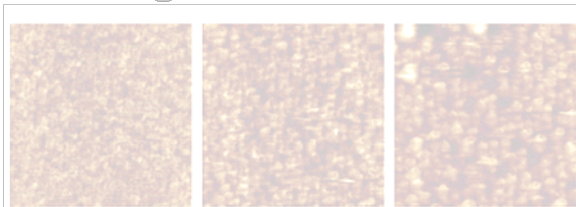
Non-periodic geometries



But in the real world...

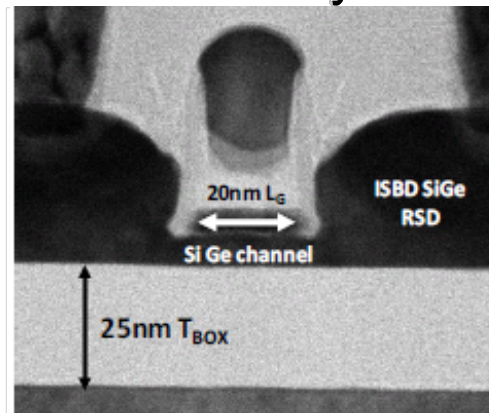


Roughness



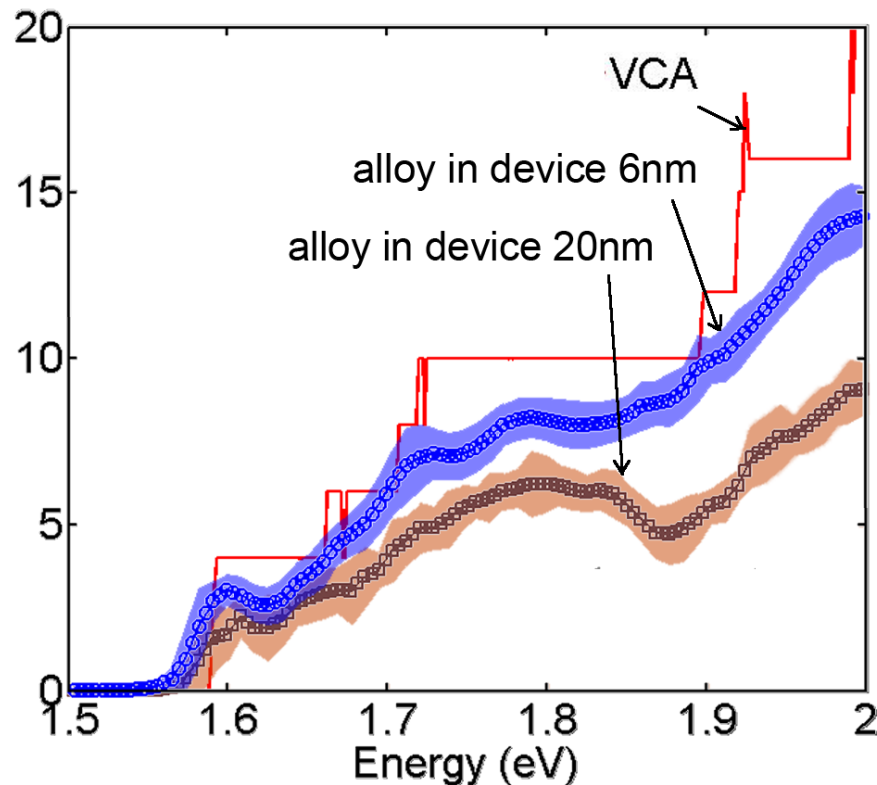
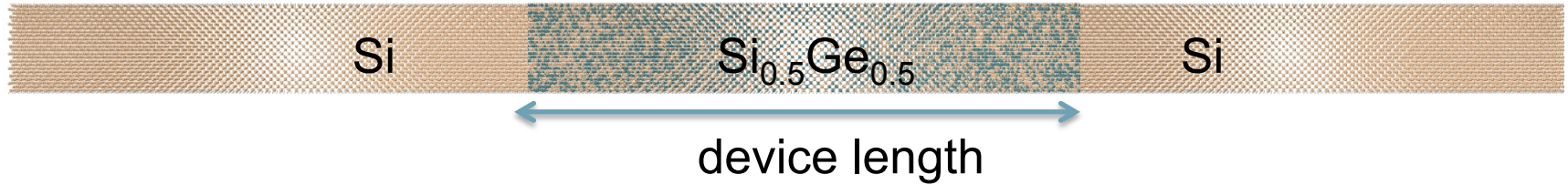
S. Koenig et al, Appl. Phys. Lett, Vol. 104, pp. 103106, 2014

Random alloy



Q. Liu, et al, IEDM p.229 2013

- Periodic assumption contradicts realistic contacts
- Method applicable for non-periodic contacts is required



Example:

3x3nm $\text{Si}_{0.5}\text{Ge}_{0.5}$ nanowire in sp³d⁵s* tight binding

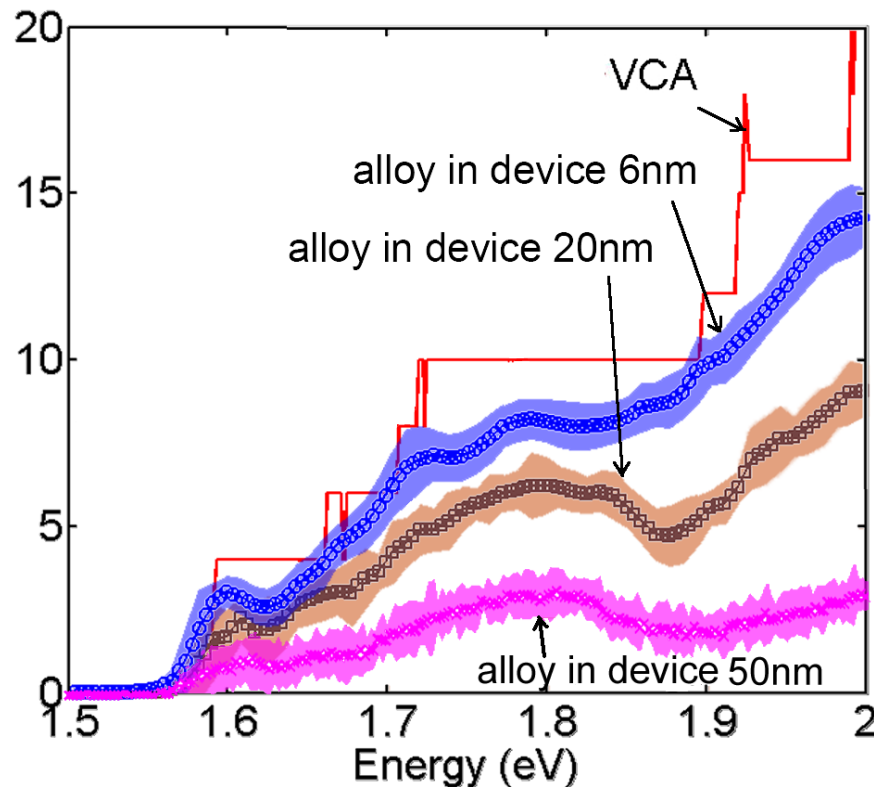
Device length 20nm and 6nm

Results averaged over 50 samples

Relaxed using Keating strain model

Keating, Phys. Rev., Vol. 145, pp. 637, 1966

DOS mismatch between alloy device and periodic contacts → longer device, less electrons tunnel through



Example:

3x3nm $\text{Si}_{0.5}\text{Ge}_{0.5}$ nanowire in $\text{sp}^3\text{d}^5\text{s}^*$ tight binding

Device length 20nm and 6nm

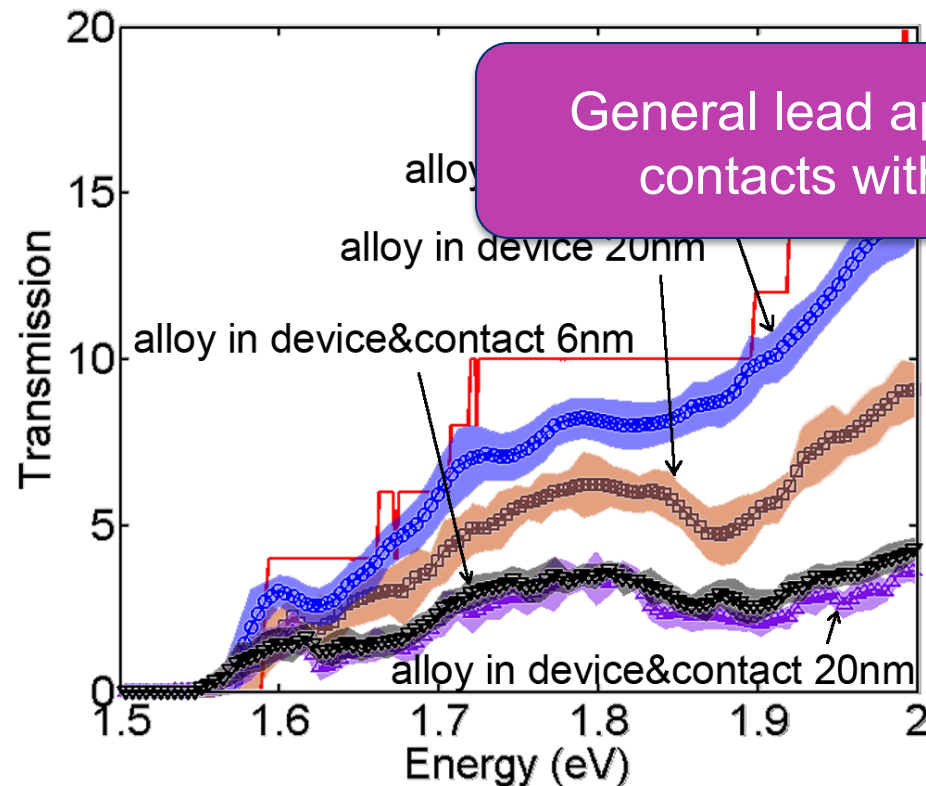
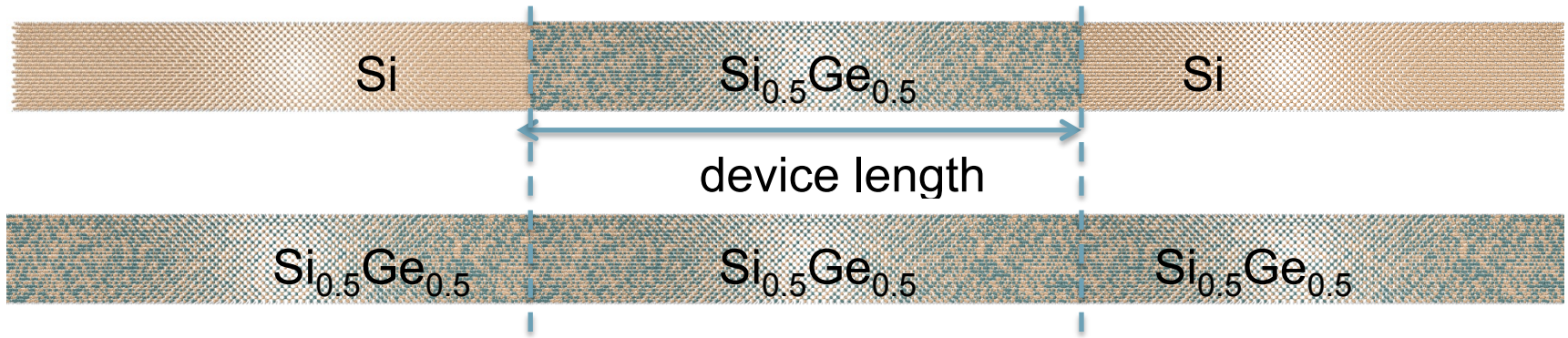
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Relaxed using Keating strain model

Keating, Phys. Rev., Vol. 145, pp. 637, 1966

DOS mismatch between alloy device and periodic contacts \rightarrow longer device, less electrons tunnel through

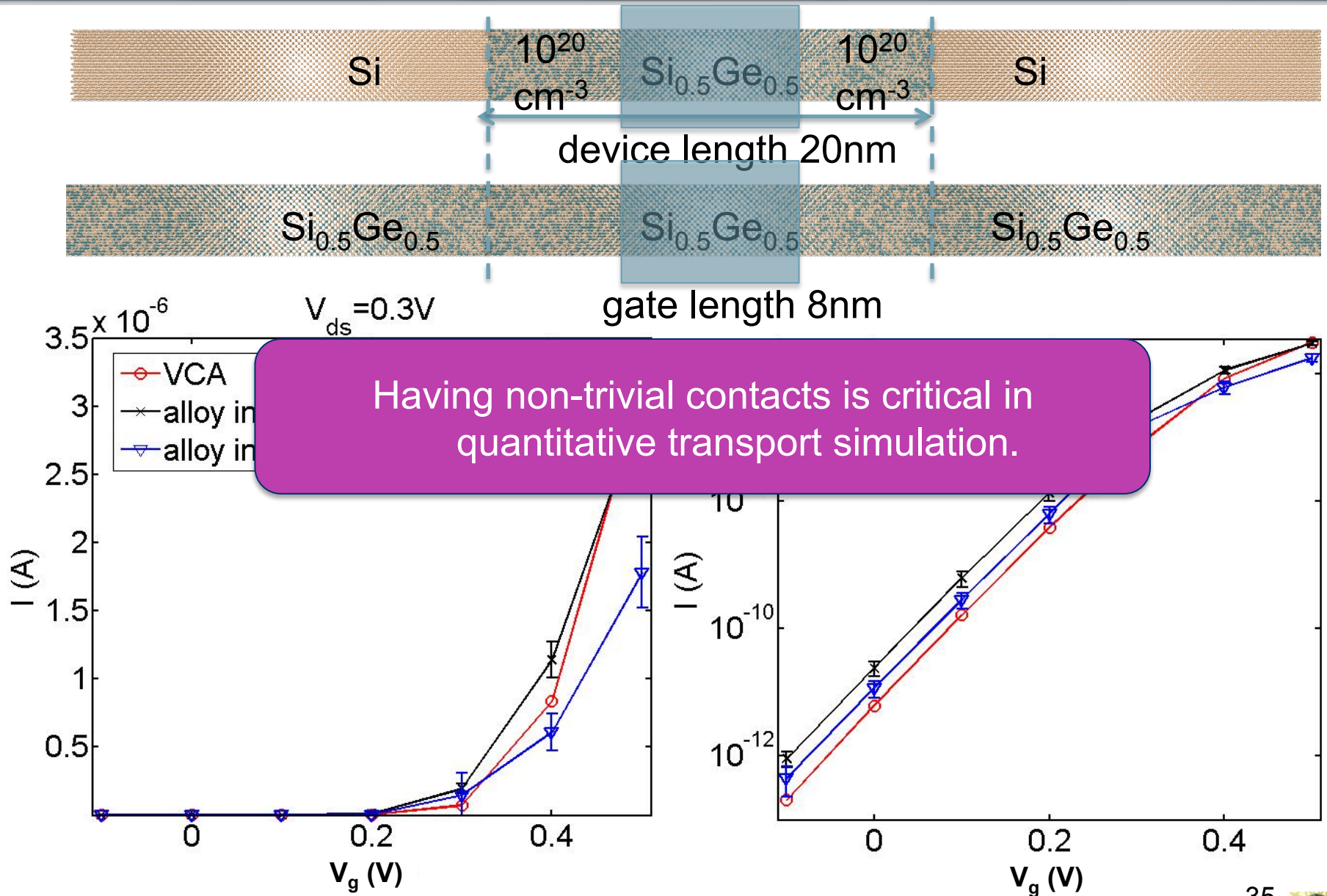
Continue to extend the device length \rightarrow transmission starts to vanish



General lead approach works well for contacts with alloy randomness

Alloyed disorder transmission has weak dependence of device length

- ✓ Alloyed contact yield virtually device length independent transmission
- ✓ DOS of contacts match device better → less reflections of electrons
- ✓ Device physics well reserved with disorder contact treatment



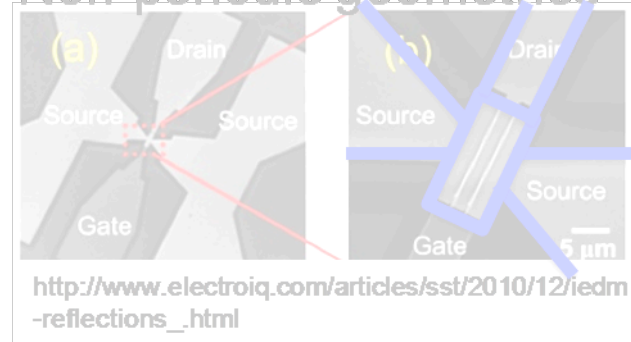
Challenges in existing self-energy methods

only solve periodic contacts
semi-infinite periodic contacts.

Common self-energy methods
Sancho Rubio,
transfer matrix

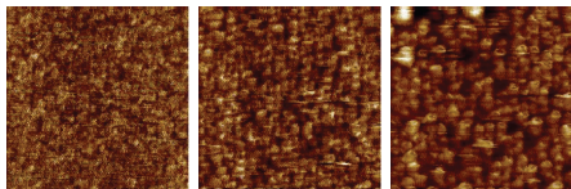


Non-periodic geometries



But in the real world...

Roughness



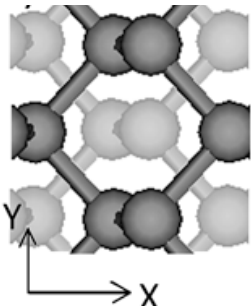
S. Koenig et al, Appl. Phys. Lett, Vol. 104, pp. 103106, 2014

Random alloy



Q. Liu, et al, IEDM p.229 2013

- Periodic assumption contradicts realistic contacts
- Method applicable for non-periodic contacts is required



Roughness

- ✓ $L_c = 1.1 \text{ nm}$, $\square = 0.2 \text{ nm}$
- ✓ Average over 50 samples

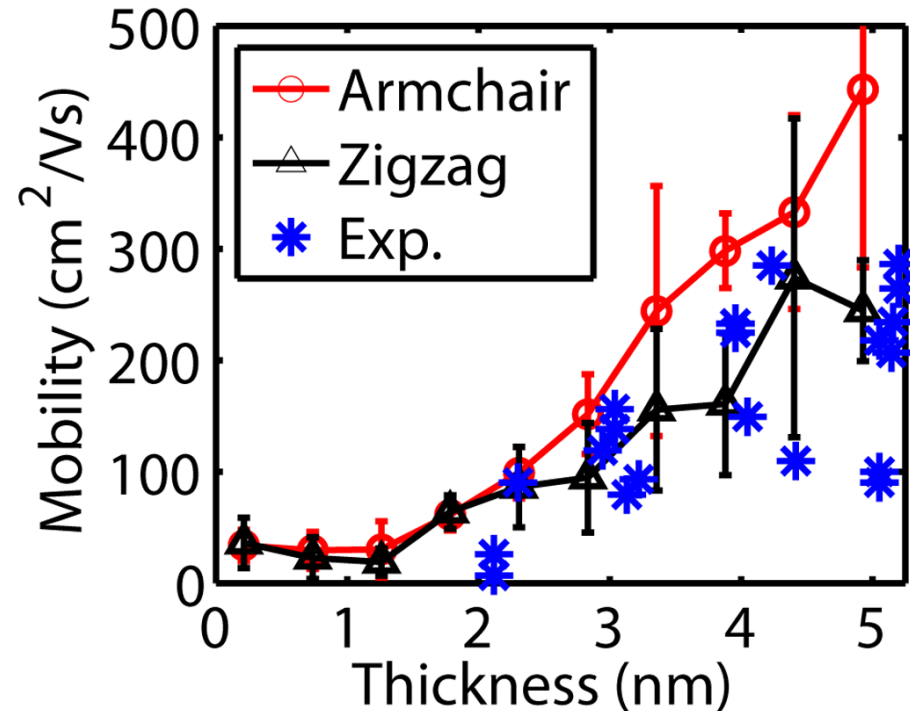
NEGF+general lead

X: armchair

Y: zigzag

- Anisotropic transport behavior is observed for thickness $> 2 \text{ nm}$ (5L)
 - ✓ Armchair $>$ zigzag
 - ✓ Impact of roughness scattering is weaker in thicker layer
- Ballistic mobility $\sim 10^4 \text{ cm}^2/\text{Vs}$
- Roughness scattering reduces mobility down to $\sim 10^2 \text{ cm}^2/\text{Vs}$
- Mobility due to roughness agrees with measurement

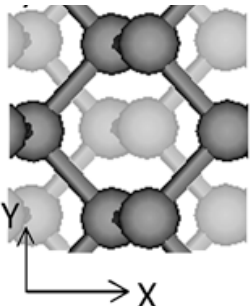
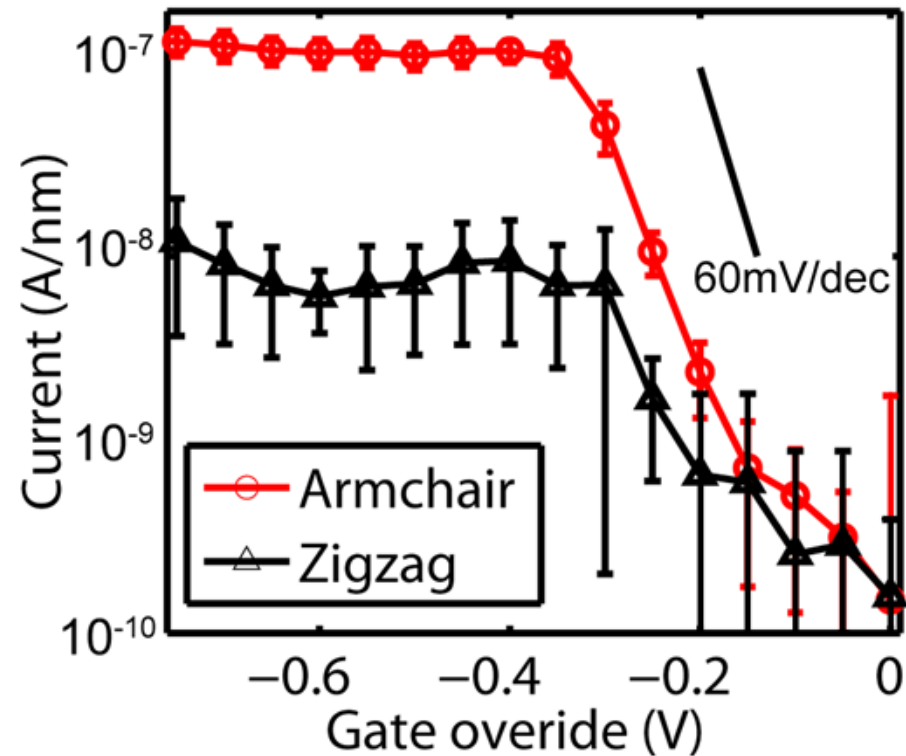
H Liu et al, ACSnano 8, 4033 (2014)
S Koenig et al, Appl. Phys. Letts. 104, 103106 (2014)



Exp. data taken from H Liu et al, ACSnano 8, 4033 (2014)

Surface roughness reduces mobility from ballistic $\sim 10^4$ to measurement $\sim 10^2 \text{ cm}^2/\text{Vs}$ \rightarrow might be one of the dominating mechanisms

- Roughness
 - ✓ $L_c = 1.1\text{nm}$, $\sigma = 0.2\text{nm}$
 - ✓ Average over 50 samples
- ITRS 2020 transistor target
 - ✓ $L = 8.5\text{nm}$, $D = 3.4\text{nm}$
 - ✓ $I_{\text{off}} = 10^{-10}\text{A/nm}$
 - ✓ $V_{\text{ds}} = 0.75\text{V}$



X: armchair
Y: zigzag

- Armchair SS 76mV/dec, ON/OFF ratio ~1400
- Zigzag SS 82mV/dec, ON/OFF ratio ~130

- Armchair direction outperforms zigzag
 - ✓ $m_{h_X} < m_{h_Y}$
- ON/OFF ratio lower than ITRS requirement $\sim 10^4$

Introduction

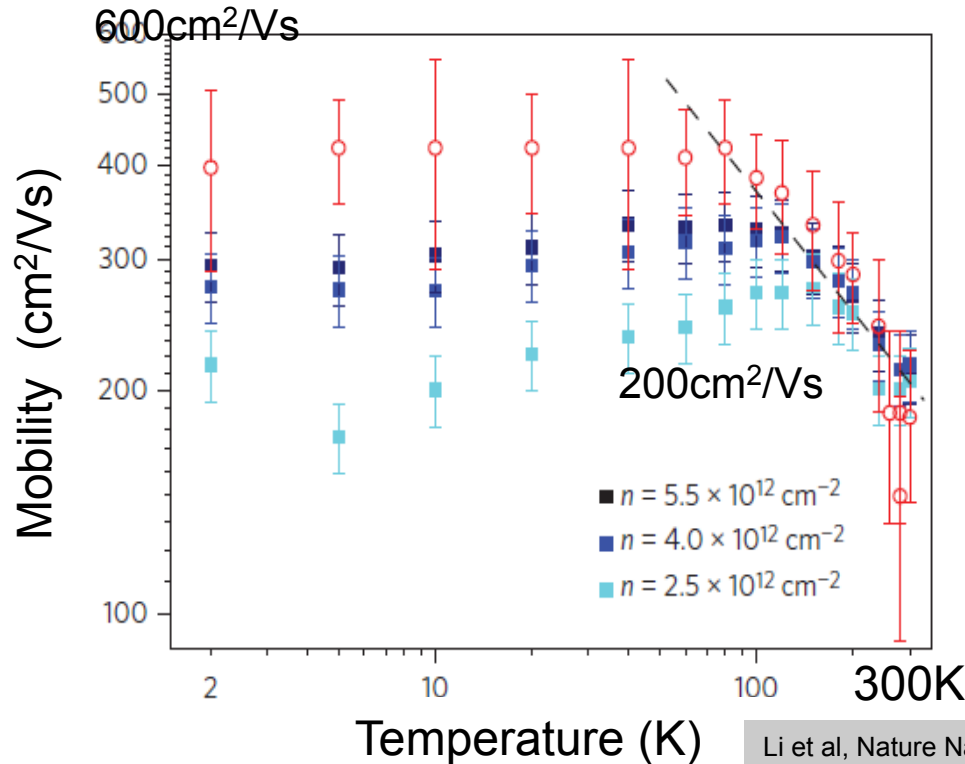
Tight-
binding
model

Surface
roughness
scattering

**Acoustic
phonon
scattering**

Conclusion
& Outlook

Temperature dependence of mobility



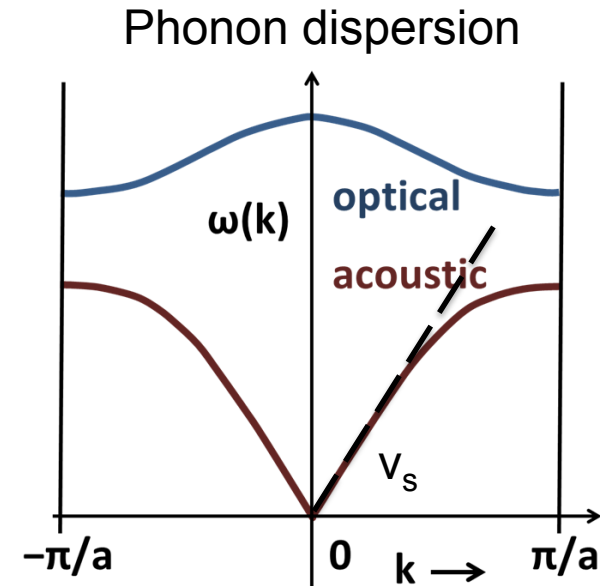
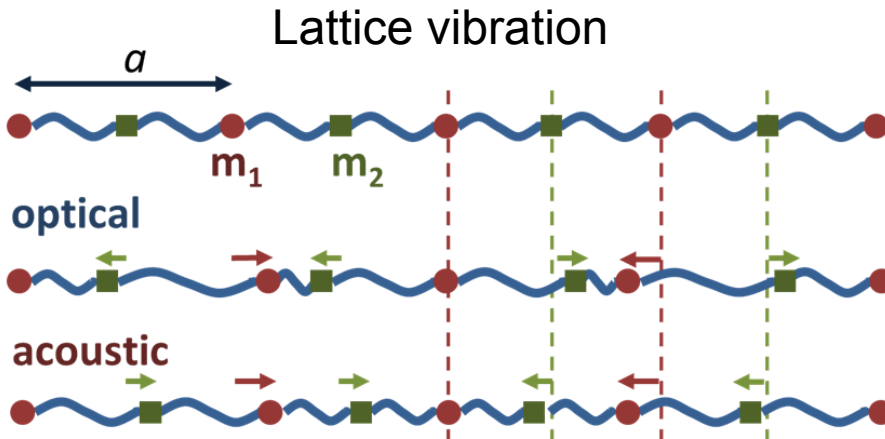
Li et al, Nature Nanotechnol. 9, 372–377 (2014)

- Mobility shows temperature dependence, with values $200 \text{ cm}^2/\text{Vs} \sim 400 \text{ cm}^2/\text{Vs}$
- Temperature dependence not attributed to roughness scattering
- Matthiessen's rule

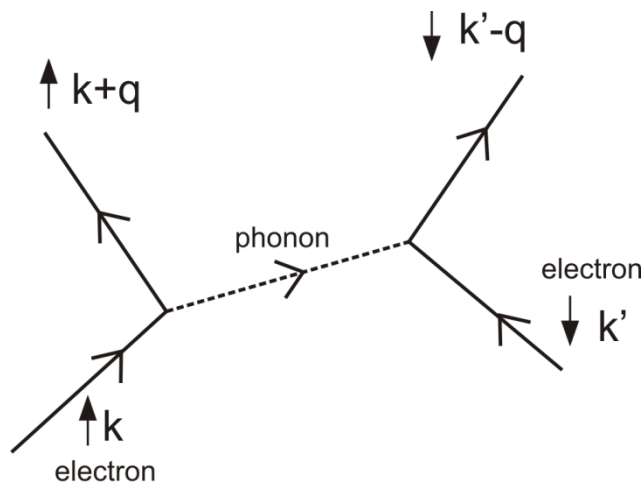
$$\frac{1}{\mu_{tot}} = \frac{1}{\mu_{SR}} + \frac{1}{\mu(T)}$$

Possible scattering mechanism for temperature dependent mobility \rightarrow phonon, impurity, ...

<https://en.wikipedia.org/wiki/Phonon>



Electron-phonon scattering



- Lattice vibration denoted by phonons (acoustic and optical)
- Electrons exchange momentum and energy with phonons
- Only acoustic phonon is considered here, optical branch is not included due to lack of parameters

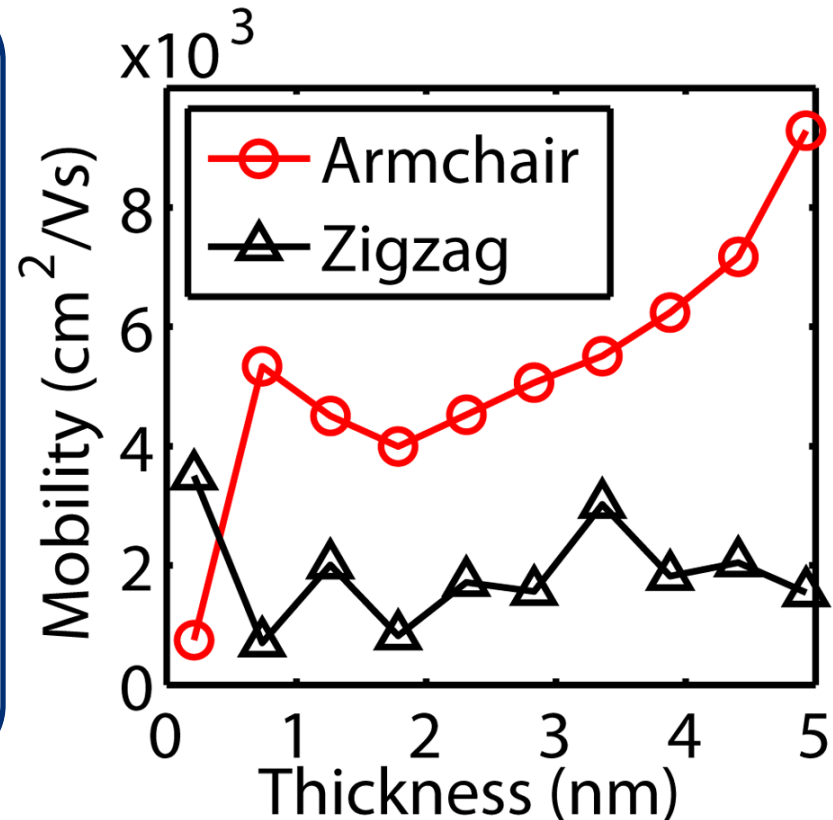
- Linear phonon dispersion is assumed
 - ✓ Material density 2.69 g/cm³

H Liu et al, Chem. Soc. Rev. 44, 2732 (2015)
 - ✓ Deformation potential: thickness dependent

J Qiao et al, Nature Comm. 5, 4475 (2014)
 - ✓ Sound velocity 3.8km/s armchair direction, 7.8km/s zigzag direction

Z Zhu et al, Phys. Rev. Lett. 112, 176802 (2014)
- Low energy, room temperature assumed
- Acoustic phonon scattering denoted by scattering self-energy, solved with self-consistent Born approximation

Lake et al, J. Appl. Phys. 81, 7845 (1997)



- Mobility shows anisotropic transport behavior
 - ✓ $m_{h_X} < m_{h_Y}$
 - ✓ Deformation potential for 1L zigzag very small (0.15eV)
- Phonon mobility $\sim 10^3$ cm²/Vs \gg measured values ~ 200 cm²/Vs (T=300K)

Room temperature mobility \gg measurement
 \rightarrow acoustic phonon does not dominate the temperature dependent mobility

Introduction

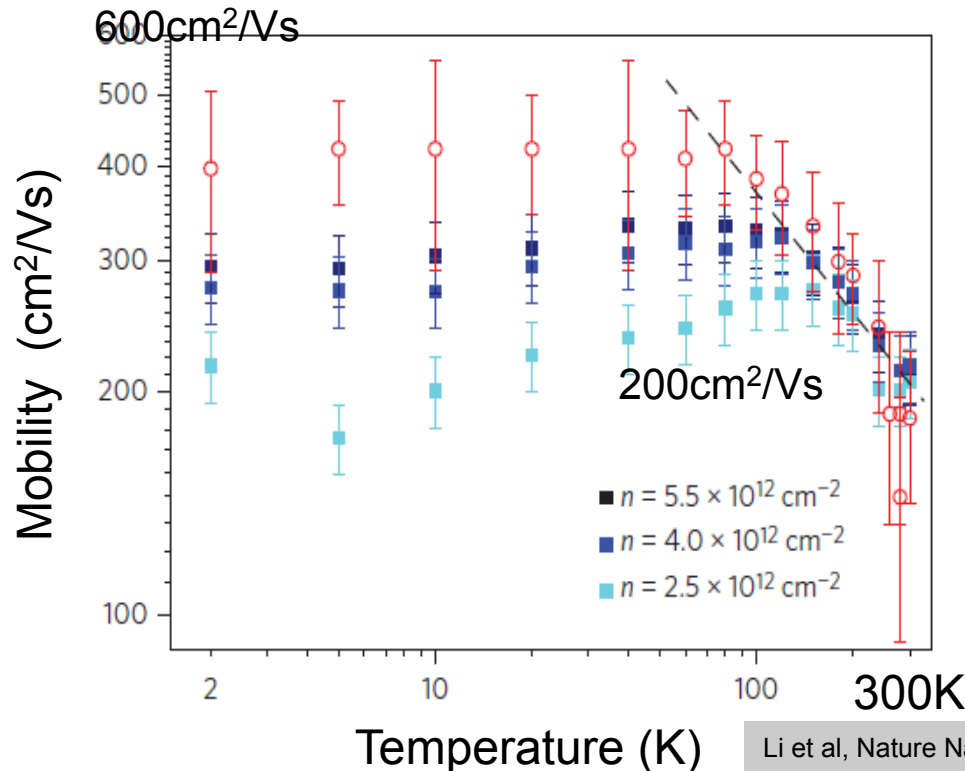
General
lead
method

Tight-
binding
model

Scattering
& mobility

**Conclusion
& Outlook**

- Measured mobility of black phosphorus transistor is lower than expected; surface roughness observed experimentally but its impact is not fully understood.
- A 10-band TB model for black phosphorus is developed.
- General lead method is developed for contact self-energy calculations of non-periodic non-ideal contacts (e.g. roughness, alloy, etc).
- Mobility due to surface roughness agrees well with measurement.
- IV characteristic based on ITRS 2020 target transistor using black phosphorus shows anisotropic properties; yet ON/OFF ratio is lower than requirement.
- Acoustic phonon scattering in black phosphorus is studied and found to be not dominating the mobility.



Li et al, Nature Nanotechnol. 9, 372–377 (2014)

- Mobility shows temperature dependence, with values 200 cm²/Vs ~ 400 cm²/Vs
- Acoustic phonon assisted mobility $> 10^3 \text{ cm}^2/\text{Vs}$ \gg measured values \rightarrow not dominate temperature dependence

- Possible mechanism that dominates the temperature dependent mobility might be optical phonon scattering
- NEGF with optical phonon scattering might provide the answer
- Require optical phonon energy and deformation potential from either DFT calculation or experiment

Tunnel Field-Effect Transistors in 2D Transition Metal Dichalcogenide Materials

Hesameddin Ilatikhameneh¹, Yaohua Tan¹, Bozidar Novakovic¹, Gerhard Klimeck¹, Rajib Rahman¹, and Joerg Appenzeller²

The simulation results show that WTe₂ TFETs can provide highest performance in terms of ON-current and SS in comparison to the other TFETs. Since WTe₂ has the smallest band gap and effective mass compared to the other TMDs, its ON-current is significantly higher. No-

H. Ilatikhameneh, Exploratory Solid-State Computational Devices and Circuits, IEEE Journal on, vol. 1, pp. 12, 2015.

$$I \propto \exp\left(\frac{-4\Lambda\sqrt{2m_r^*E_g}}{3\hbar}\right) \quad \eta = \Lambda\sqrt{m_r^*E_g}$$

Material	I_{ON}	E_g	m_r^*	λ	Λ	η
WTe ₂	127	0.75	0.17	0.45	2.45	3.15

- ON-state current of TFET depends on effective masses and band gap
- Black phosphorus can be a nice candidate to explore
 - ✓ Armchair direction gives small effective masses
 - ✓ Band gaps decrease fast with number of layers

	1L	2L	3L	4L	5L
m_r^*	0.0927	0.0851	0.0719	0.0657	0.0620
E_g	1.374	0.8419	0.573	0.466	0.41

- Prof. Klimeck
- Prof. Datta, Prof. Rokhinson, Prof. Kubis
- Prof. M. Povolotskyi, Dr. J. Fonseca, Dr. B. Novakovic, Dr. J. Huang, Dr. L. Zeng, Dr. G. Hegde, Dr. S. Mehrotra, Dr. S. Park, Dr. S. Kim, Dr. H. Park, Dr. A. Ajoy, Dr. S. Steiger
- **NCN people:** Z. Jiang, J. Geng, Y. Tan, D. Mejia, K. Miao, Y. Hsueh, M. Salmani, X. Wang, H. Ilatikhameneh, D. Lemus, P. Long, F. Chen, Y. Wang and P. Sarangapani , all other students in NCN.
- **NCN Staff members:** V. Johnson, C. Heins, L. Schumacher, A. Buckles
- **NEMO5 core team:** Prof. M. Povolotski, Prof. T. Kubis, Prof. R. Rahman, Dr. J. Fonseca, Dr. B. Novakovic , Dr. J. Huang

Related Publications

- Yu He, Yaohua Tan, James Charles, Gerhard Klimeck, and Tillmann Kubis, “Transport in few-layer black phosphorus with empirical tight binding”, under preparation.
- Yu He, Yaohua Tan, Zhengping Jiang, Michael Povolotskyi, Gerhard Klimeck, and Tillmann Kubis, “Surface passivation in empirical tight binding”, submitted to *IEEE Trans. Electr. Dev.*, 2015.
- Yu He, Yu Wang, Gerhard Klimeck, and Tillmann Kubis, “Nonequilibrium Green’s Function Method: Non-trivial and disordered leads”, *Appl. Phys. Lett.*, Vol. 105, pp. 213502, 2014.
- Yu He, Tillmann Kubis, Michael Povolotskyi, Jim Fonseca, and Gerhard Klimeck, “Quantum transport in NEMO5: algorithm improvements and high performance implementation”, *2014 International Conference on Simulation of Semiconductor Processes and Devices*, Yokohama, Japan, 2014.

List of projects

Objective:

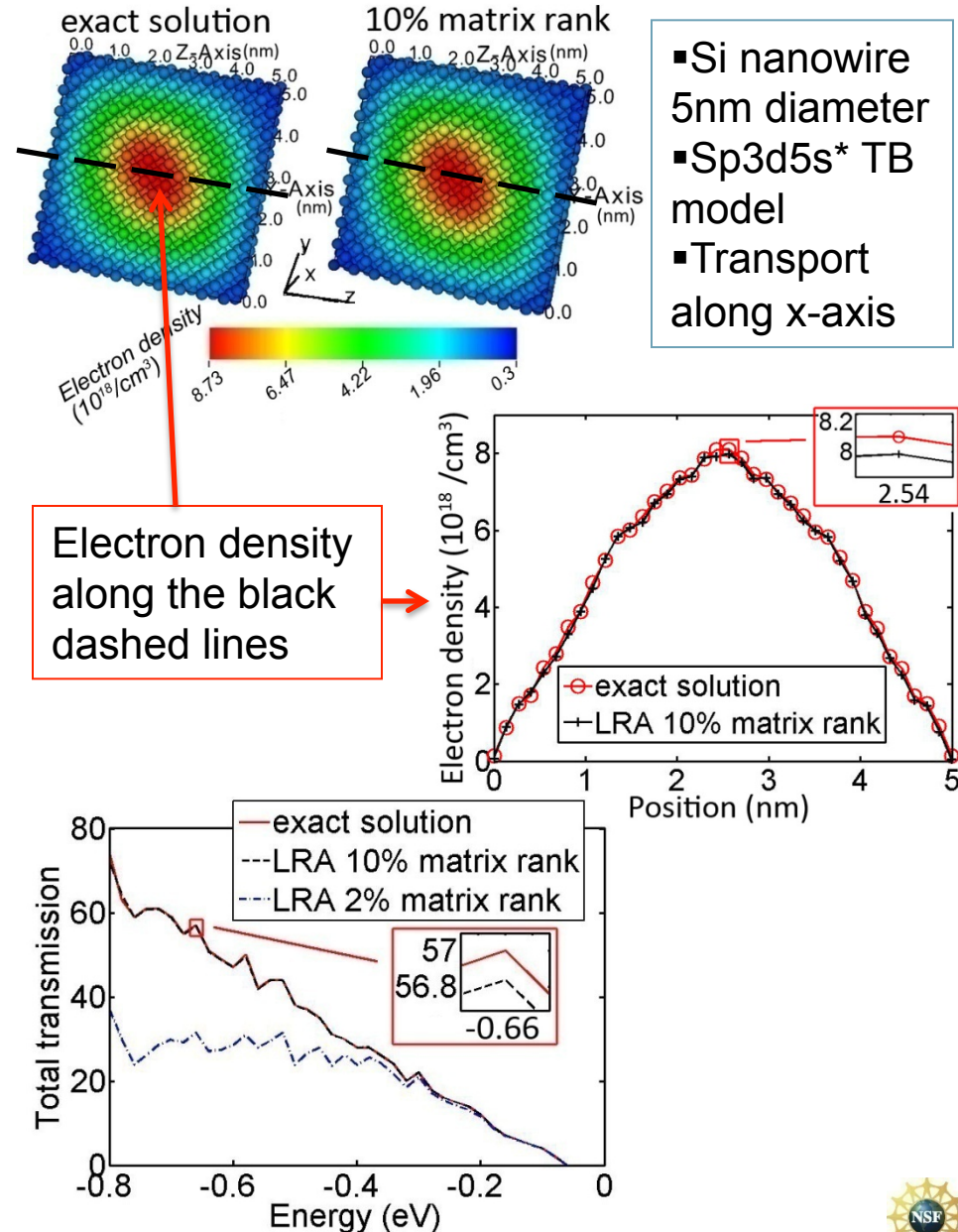
- Quantum transport is numerically very expensive for realistic devices
 - Realistic device requires huge simulation domain \rightarrow huge computational resources
 - Operation of large Matrices with the size of device Hamiltonian

Method:

- Non-equilibrium Green's functions in atomistic tight binding representation
- Low rank approximation in appropriate basis set
 - Transform the system into a reduced space with much smaller size
 - Perform all operations in the reduced space

Impact:

- 5nm diameter Si nanowire
- 10% of original matrix size (rank)
- Speed up by 8 times achieved
- With almost no loss in transmission and electron density



Objective:

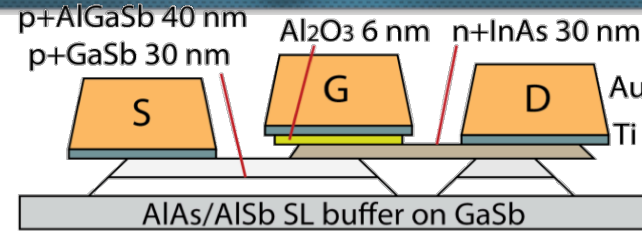
- Real BTBT device → Huge simulation domain requires huge computational resources

Method:

- Low rank approximation in NEGF with Tight binding representations
- Extract critical elements from computational domain → reduce problem size to save resources

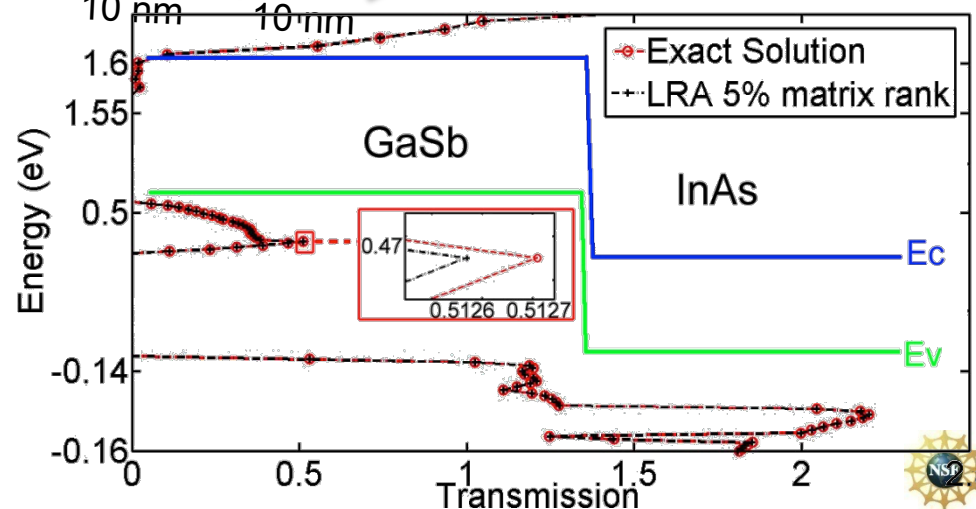
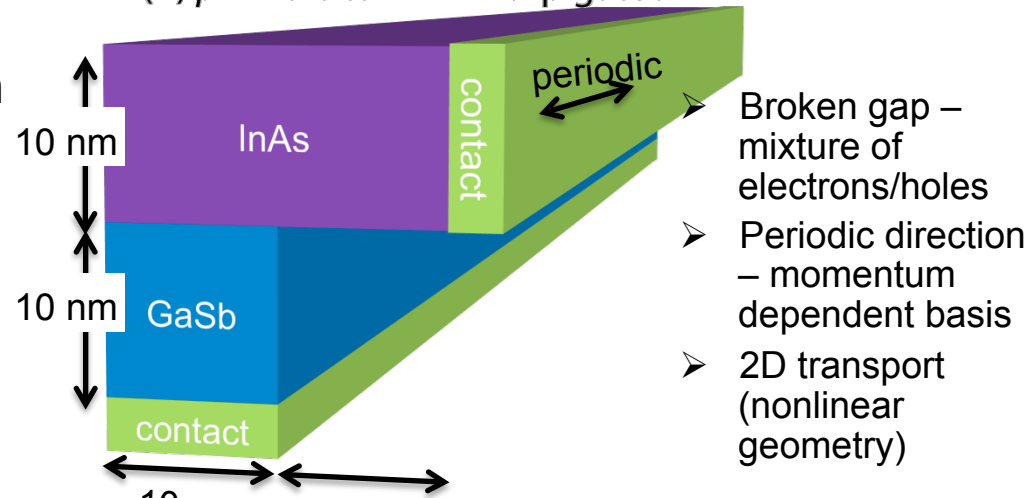
Impact:

- Use only 5% of full basis in L-shape GaSb-InAs BTBT, with almost no loss in accuracy
- Reduce matrix operations by $(1/0.05)^3 = 8,000$ times
- Open a way to simulate realistic BTBT devices



(b) *p-n* vertical TFET - top gated

L-shape GaSb-InAs tunneling FET



Objective:

- NEGF transport with phonon scattering is expensive \rightarrow self consistent Born solution $\sim 100\times$ to ballistic calculation.

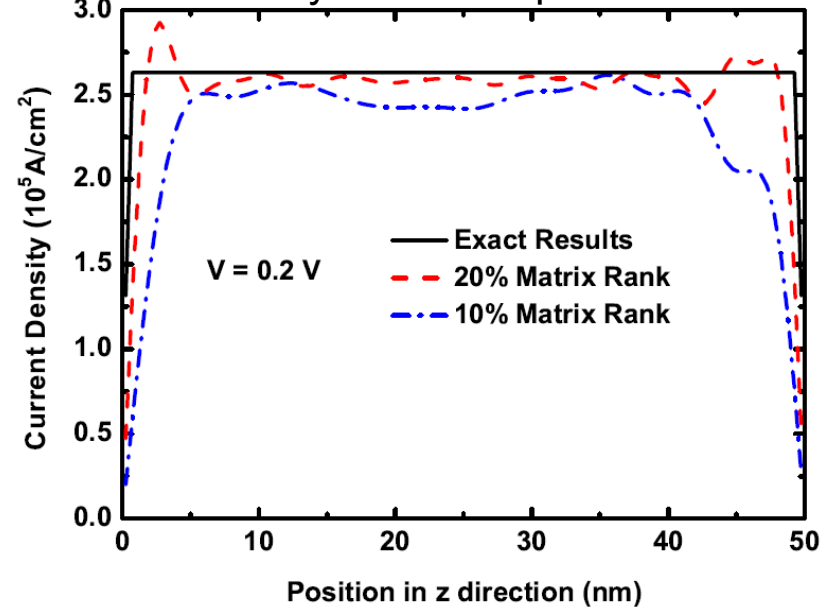
Method:

- Construct reduced real space basis in the relevant states only.
- Transform original NEGF equation into reduced space with the obtained basis.
- Solve NEGF+scattering in the reduced space.
- Transform back into original space to calculate the observables.

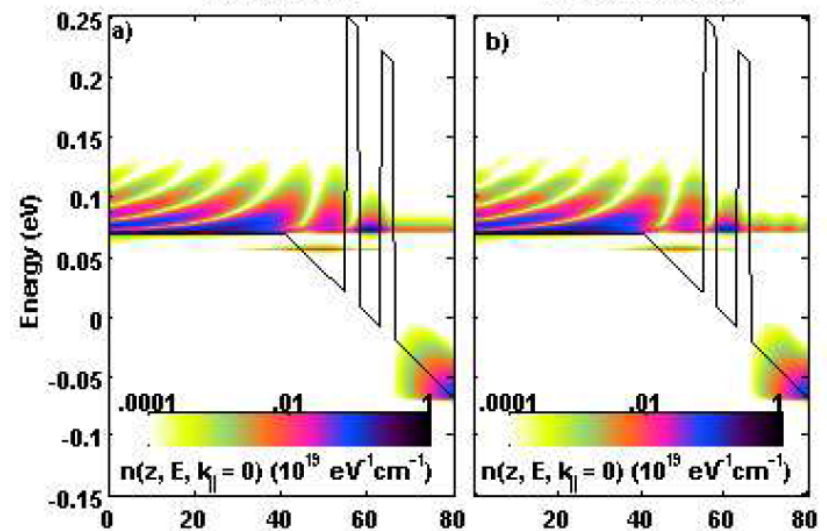
Impact:

- With 10% of original matrix rank the charge density and current density is well reproduced.
- Speed up $>100\times$ is achieved.

Current density for GaAs quasi 1D device



Charge density for GaAs/Al_{0.3}Ga_{0.7}As RTD



Objective:

- Investigate NEGF calculation towards drift-diffusion limit in long device.

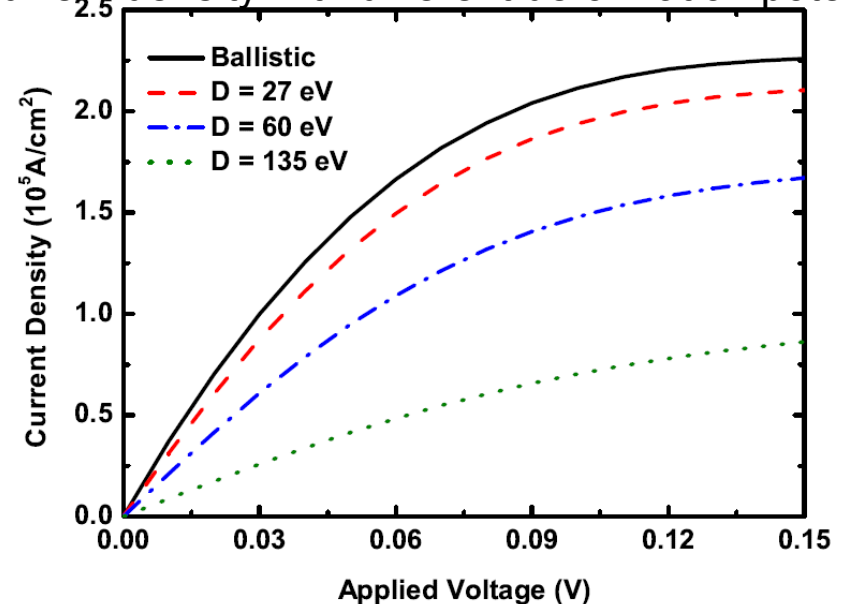
Method:

- LRA+NEGF with phonon scattering.
- Investigate different scattering rate (phonon deformation potential D).

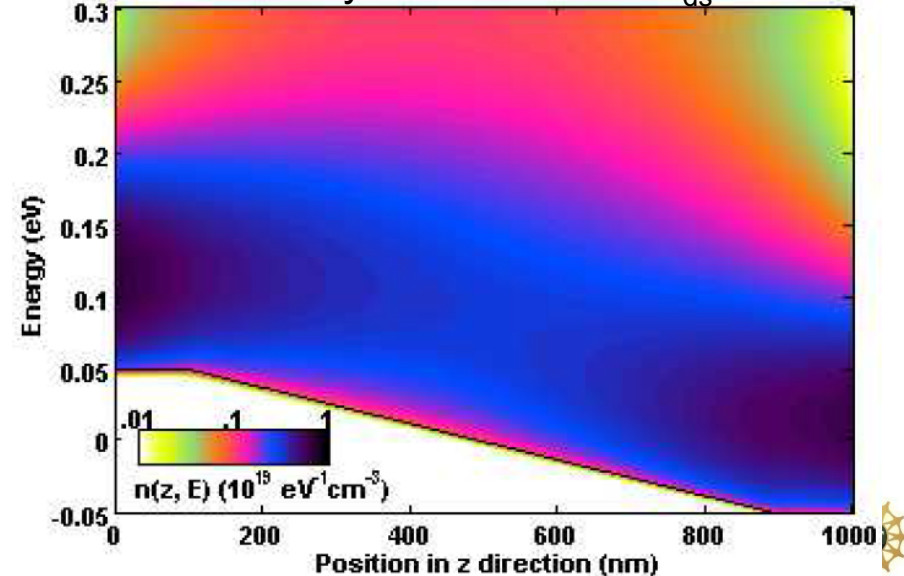
Impact:

- With 20% of original matrix rank the I-V characteristic is achieved, while exact solution is not feasible.
- With $D=135\text{eV}$ energy dissipation is observed in the charge density.
- Transition from effective ballistic transport into drift-diffusion is observed in the device channel.

Current density with different deformation potential



Electron density with $D=135\text{eV}$ $V_{ds}=0.1\text{V}$



Objective:

- Solving contact self-energy is expensive in tight binding model, especially for big cross-section device.

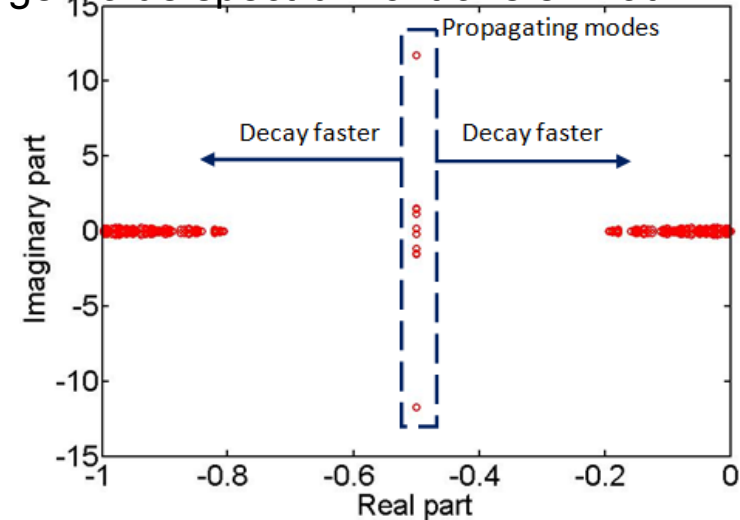
Method:

- Transfer matrix method is adopted.
- Solve the eigenvalue spectrum such that keep only the propagating modes and slowly decaying modes in the solution.
→ propagating modes with Real part of eigvalues $\approx -0.5\text{eV}$

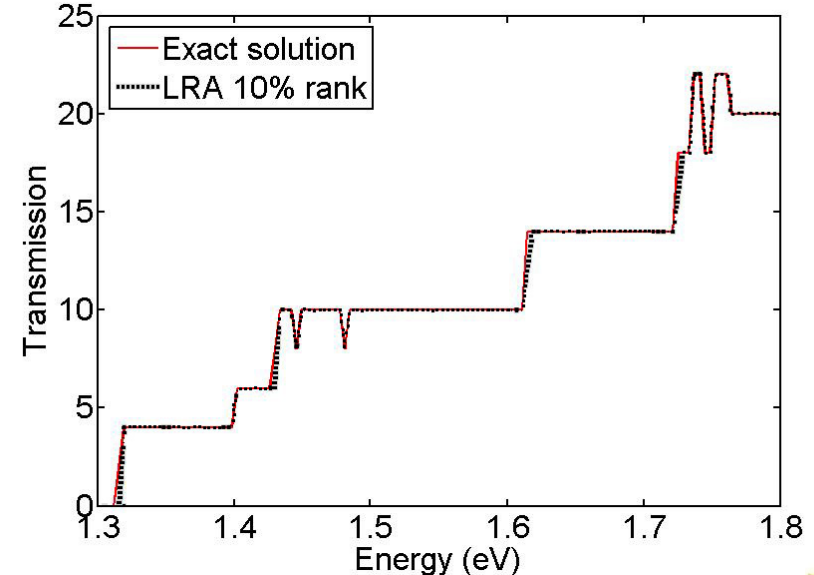
Impact:

- Significantly reduce the numerical load and speed up $\sim 3\text{x}$ in self-energy calculation.
- Results are well reproduced with 10% of original matrix rank.

Eigenvalue spectrum of transfer matrix method



Transmission w/wo LRA in contact self-energy



Objective:

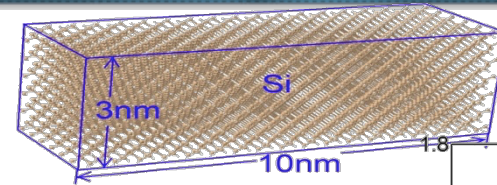
- Common lead methods can only deal with semi-infinite periodic leads
- Realistic leads are non-periodic

Method:

- Assume some lead self-energy far from the lead/device interface
- Add artificial dephasing to the lead Hamiltonian that decays fast towards device
- Solve lead surface Green's function via RGF until convergence

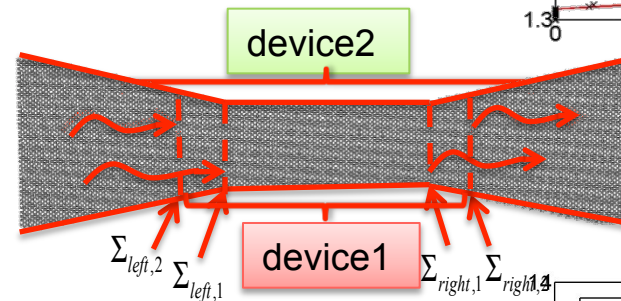
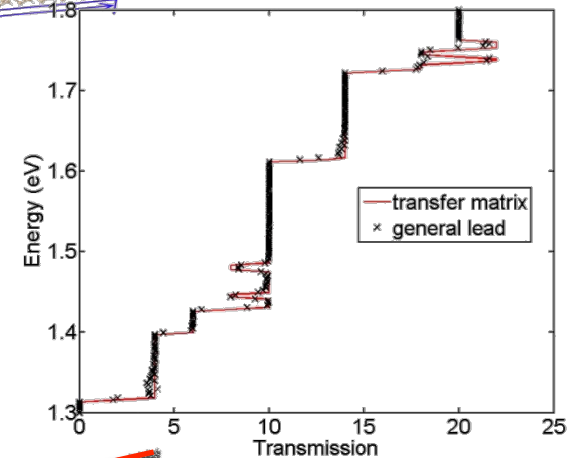
Impact:

- General lead algorithm agrees with common method for regular leads, deviations observed only very close to van Hove singularities
- General lead method can represent irregular lead geometry



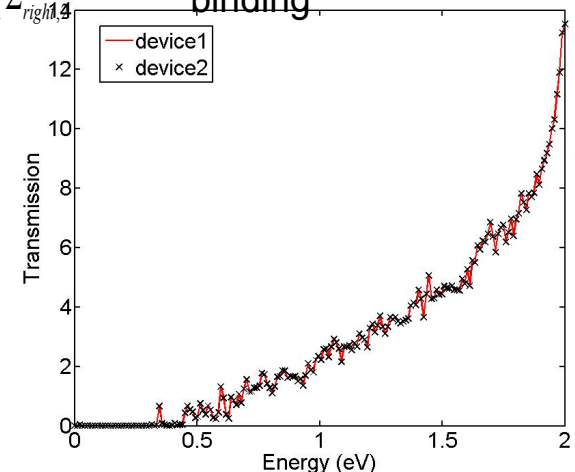
3x3nm Si nanowire in $sp^3d^5s^*$ tight binding

Transmission comparison common method vs. general leads



20x10nm graphene nanoribbon with trumpet shaped leads, Electrons in P/D tight binding

- Device1 and device2 are physically equivalent
- Transmission identical for device1 and device2



Objective:

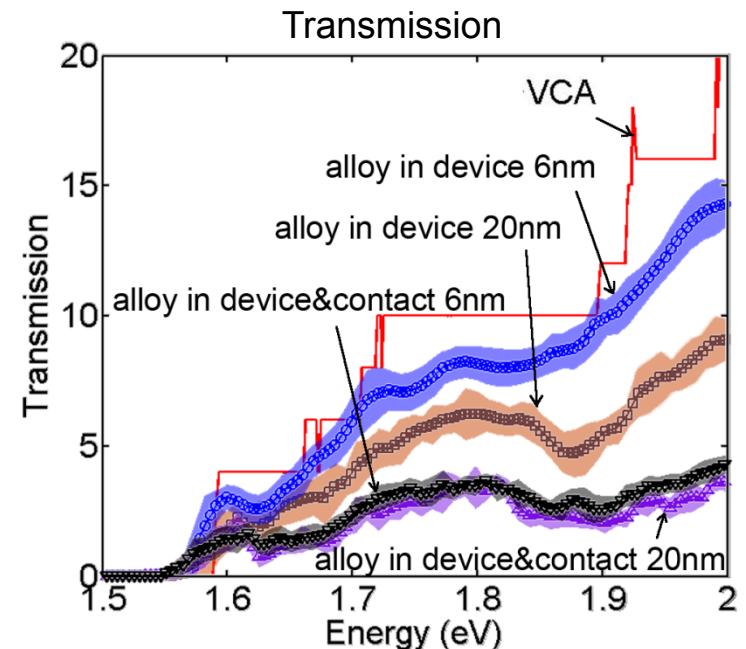
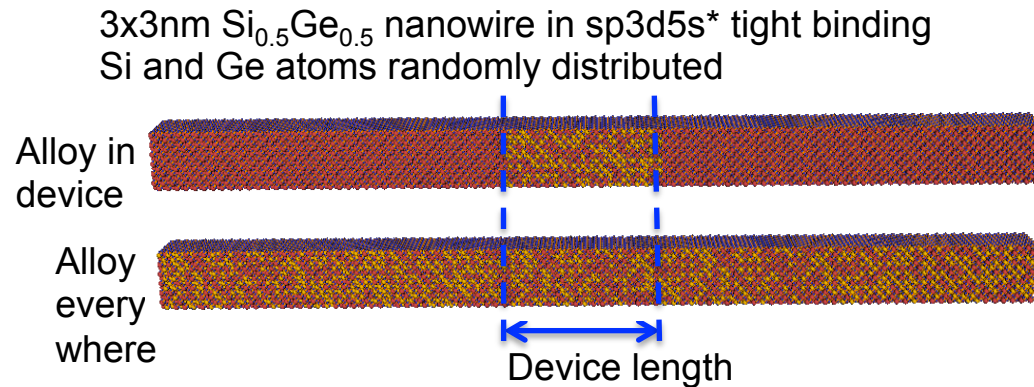
- Device lengths approach ballistic limit, contact resistances dominate;
- Random alloy in the leads influence overall performance

Method:

- Include random alloy in the leads
- Apply general lead algorithm to solve the leads with alloy

Impact:

- 50 samples are simulated.
- Alloy disorder in leads yields length independent transmission.
- DOS of alloy leads matches with alloy device better.
- General lead algorithm can represent randomness in leads.



Objective:

- Dangling bonds at surfaces introduce undesired eigenstates within band gap → need to be passivated;
- Existing model works for zincblende and diamond structure only → general and flexible model required;

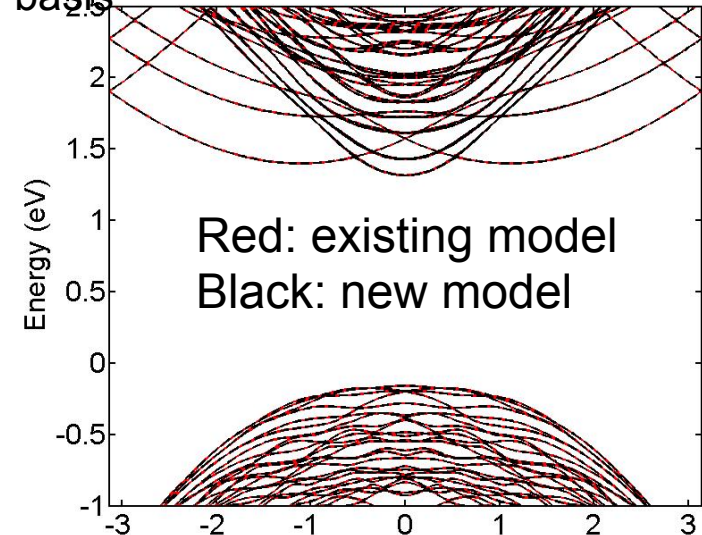
Method:

- Explicitly add passivation materials (H, O, SiO₂, etc) to the structure;
- The surface atoms are passivated by a self-energy of the passivation materials;
- Parameters are optimized by fitting TB results to DFT results.

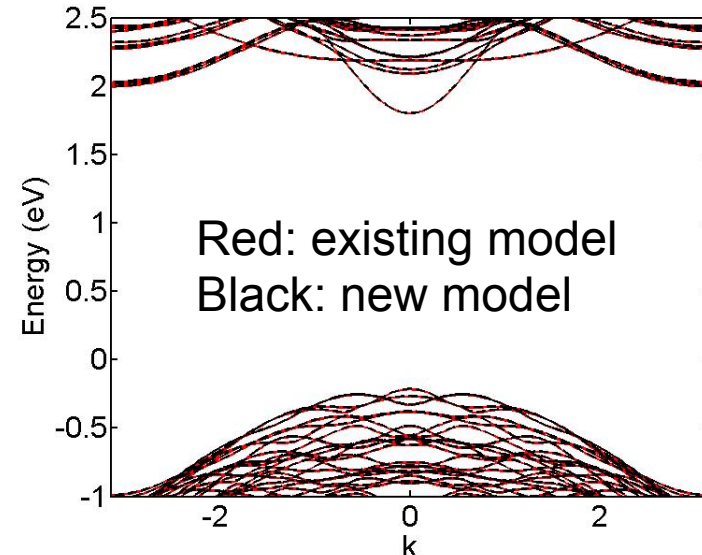
Impact:

- Bandstructure matches well with the existing model on zincblende and diamond structure with proper parameters.

Bandstructure for 3nm x 3nm Si nanowire, sp³d⁵s* basis



Bandstructure for 3nm x 3nm GaAs nanowire, sp³d⁵s* basis



Objective:

- Investigate the Si UTB/SiO₂ interface and evaluate the normally used hydrogen atom passivation treatment.

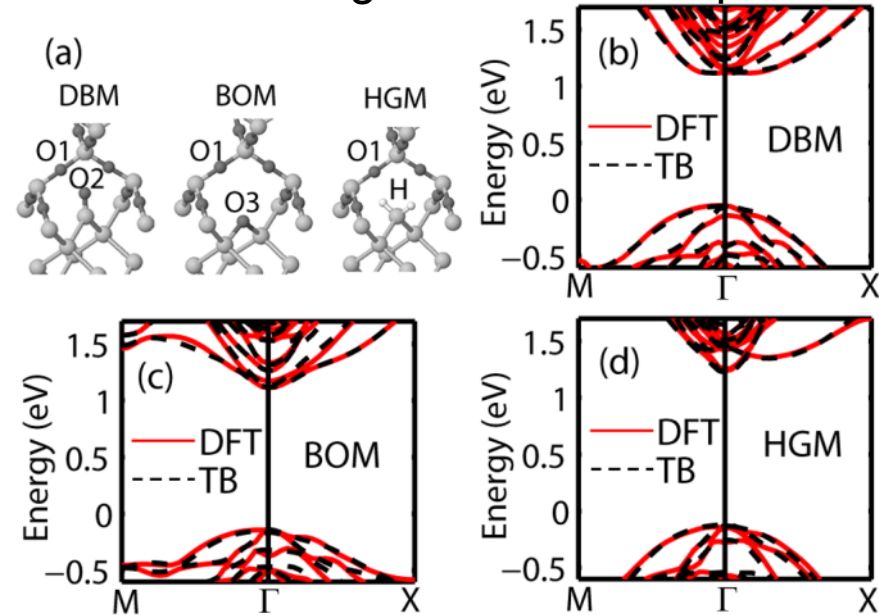
Method:

- Passivation for three relevant oxidation configurations are parameterized.
- Parameters are optimized by fitting TB dispersions to DFT-HSE06 calculations.

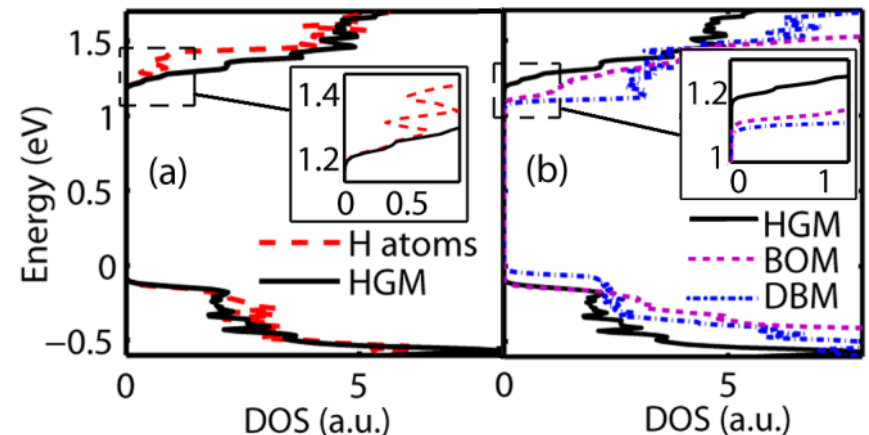
Impact:

- UTB band structures of TB match well with DFT calculations.
- HGM gives higher DOS compared to hydrogen atom passivation.
- Oxidation configurations involved more oxygen atoms contribute higher DOS.
- DBM and BOM configurations are not well confined, which are suggested to be avoided in experiment.

oxidation configurations and dispersions



DOS for the oxidation configurations



Objective:

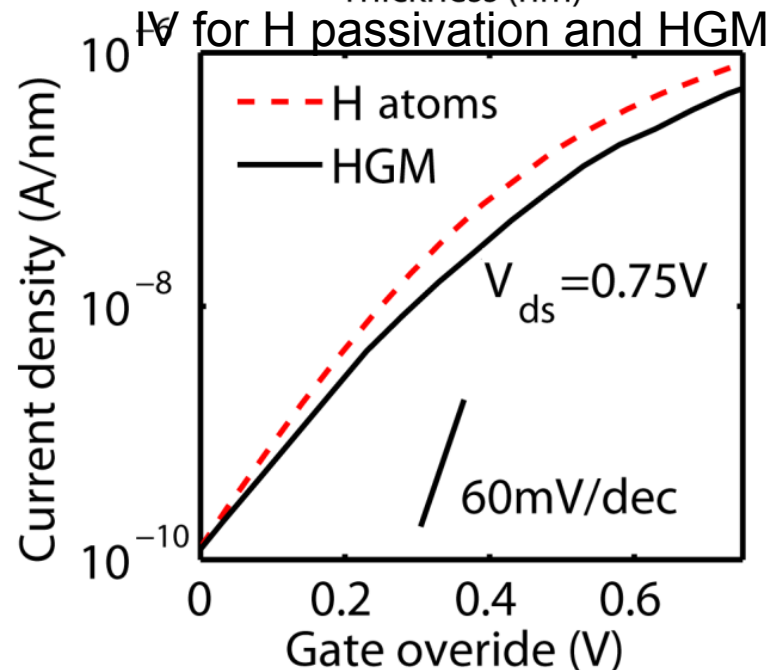
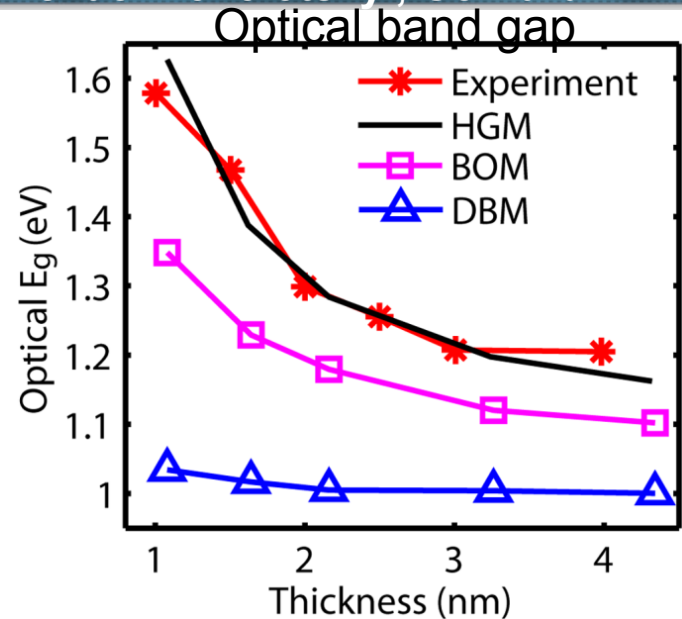
- Investigate the Si UTB/SiO₂ interface and evaluate the normally used hydrogen atom passivation treatment.

Method:

- Optical band gaps are calculated by considering the exciton energies, and compared to measurements.
- ITRS2020 target UTB transistors are simulated with H atom passivation and HGM configuration.

Impact:

- HGM shows nice agreement to measurement in band gaps for various UTB thickness.
- H atom passivation overestimates the transistor performance compared to proper oxidation.



Objective:

- Existing four-band tight binding model underestimates band splitting \rightarrow might affect charge distribution especially if scattering exists.

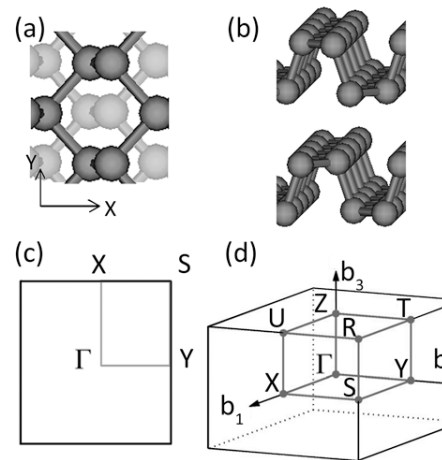
Method:

- Ten-band TB model considering 2NN interactions.
- Harrison's scaling law for bond length dependence of parameters.
- One parameter set for in-plane, one parameter set for inter-layer.
- Optimize parameters by fitting to DFT, for monolayer, bilayer, and bulk.

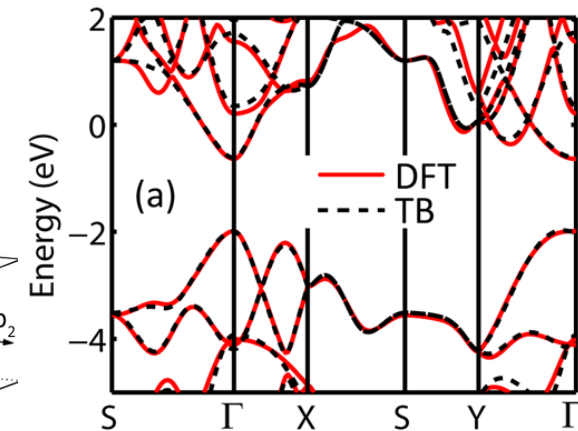
Impact:

- TB bandstructure well reproduce DFT results.
- Band splitting is well captured.

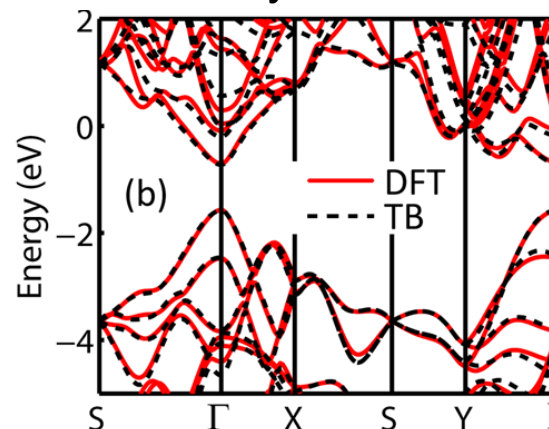
Structure and BZ



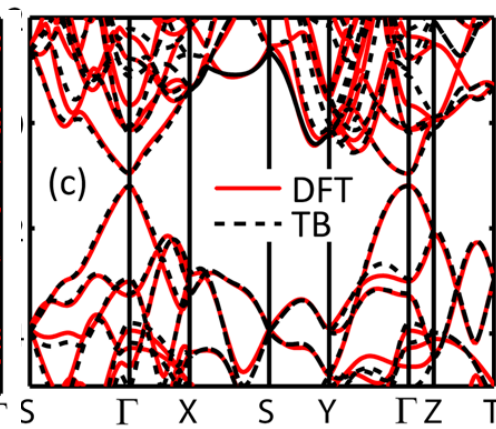
monolayer



bilayer



bulk



Objective:

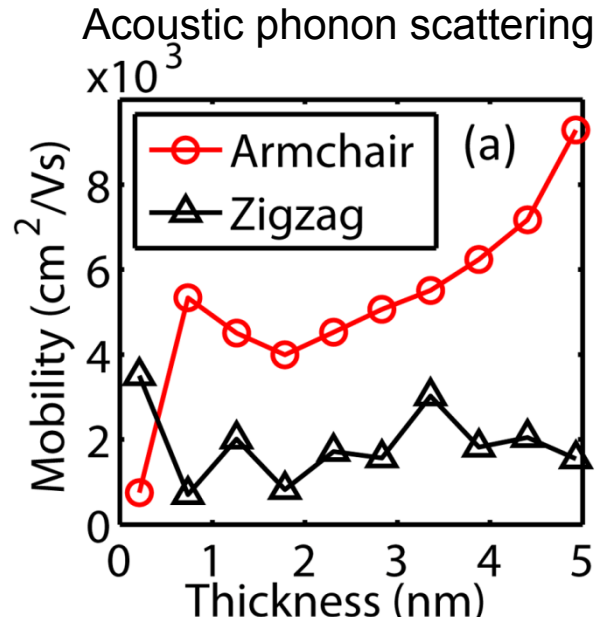
- Measured mobility $300\text{cm}^2/\text{Vs}$ \ll expected value of $10^4\text{cm}^2/\text{Vs}$.
- Surface roughness experimentally observed while its impact not fully understood.

Method:

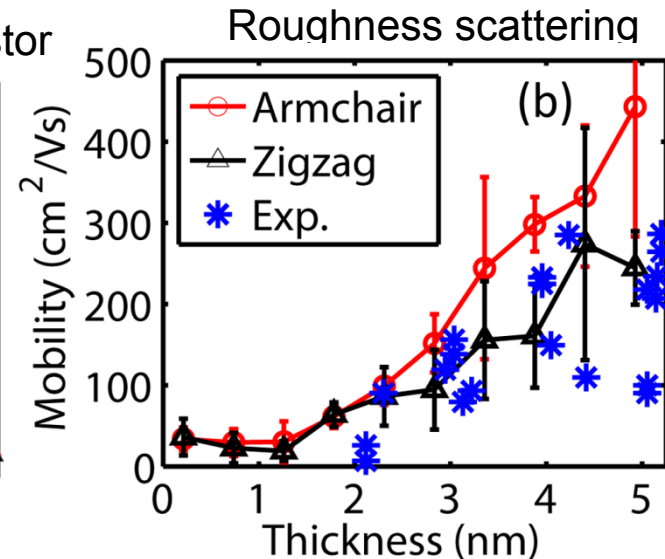
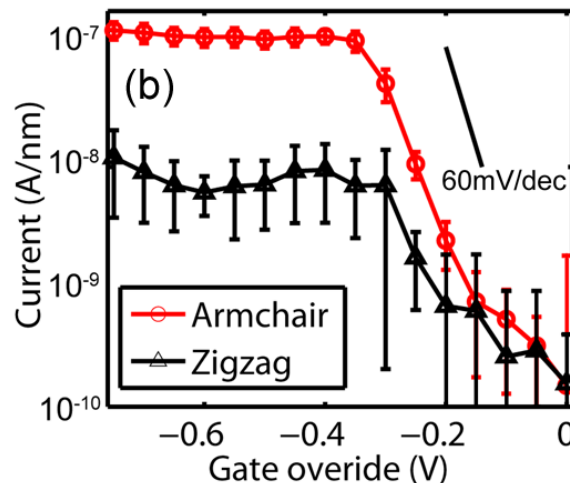
- NEGF+TB with scattering.
- Acoustic phonon and surface roughness scattering are considered.
- ITRS2020 target transistor using black phosphorus is studied.

Impact:

- Acoustic phonon mobility $>10^3\text{cm}^2/\text{Vs}$ suggests it is not dominant mechanism.
- Roughness scattering mobility matches well with measurement suggests it is the dominant mechanism.
- IV demonstrates the anisotropic properties.



I-V for ITR2020 target transistor



Objective:

- Randomness such as interface roughness and alloy has significant effects on BTBT device performance.

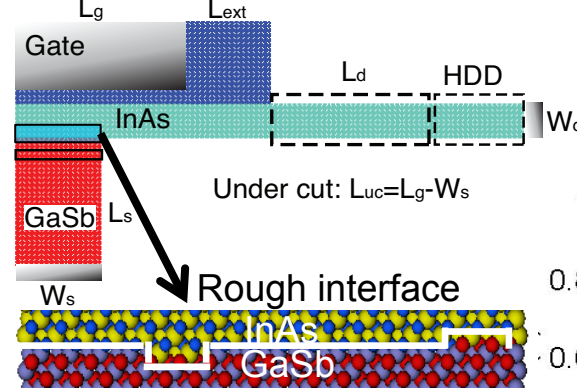
Method:

- Simulate I-V characteristics for randomly generated alloy/roughness structures of BTBT device.

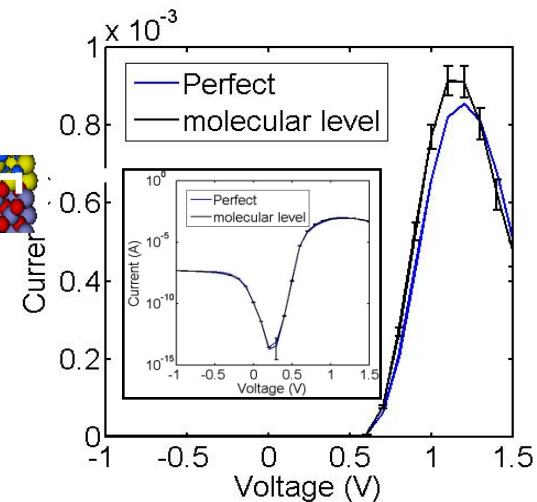
Impact:

- 500 samples for random alloy/interface roughness in GaSb-InAs TFET are simulated.
- AlGaSb random alloy with different Al fractions, decreases on-state current by ~10 times
- GaSb/InAs interface roughness increases the on-state current by ~9%

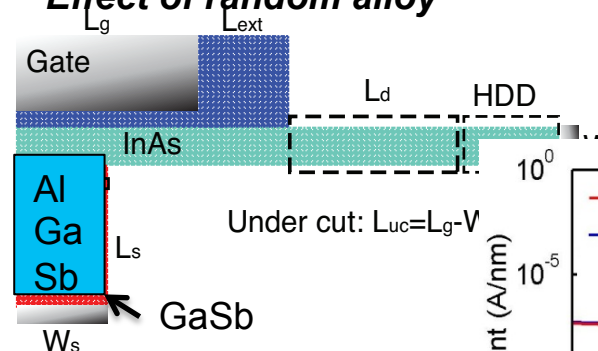
Effect of interface



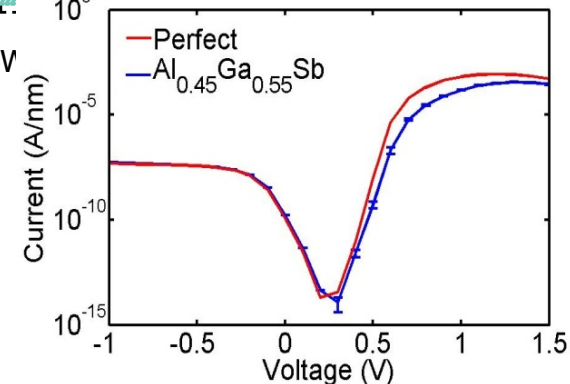
roughness at GaSb-InAs interface



Effect of random alloy



AlGaSb random alloy



Thank you !

Back up

- TB model: $sp^3d^5s^*$, different onsite energy for p_x and p_y .
- Consider 2nd NN, bond length dependence of parameters considered with Harrison's scaling law

$$U = U_0 \left(\frac{d_0}{d} \right)^\eta$$

T Boykin et al, Phys. Rev. B 66, 125207 (2002).

- Interatomic interactions: generic model, different parameters for in-plane and interlayer couplings

- Ab-initio mapping method to obtain TB parameters
→ optimize TB parameters by fitting TB results to DFT calculations

Y Tan et al, J. Comput. Electron. 12, 56 (2013)

- Fitting target: monolayer, bilayer, bulk
→ transferable for arbitrary layers

Low field resistance of channel length L written

$$R = R_0 + \frac{L}{\mu n q}$$

R_0 is contact resistance independent of L

With given scattering mechanism, mobility can be written

$$\mu = \frac{\Delta L}{\Delta n} \frac{1}{q \Delta R}$$

Y Niquet et al, J. Appl. Phys. 115, 054512 (2014)

Transport solved with NEGF and mobility extracted:

- Acoustic Phonon
- Surface roughness

- The roughness effects are generated by randomly distributing the atoms at the black phosphorus surfaces
- Distribution controlled by autocovariance function

$$ACVF_{ij} = \Delta^2 \exp(-\sqrt{2} |r_i - r_j| / L_c)$$

r_i, r_j the coordinates of surface atoms i, j

Δ root mean square of roughness

L_c correlation length

Kim et al, IEEE Trans. Elect. Dev. 58, 1371 (2011).

- Atomistic structure changes with surface roughness → device Hamiltonian changes
- Surface roughness exists in both device and contacts → **RGF+general lead** method
- $\Delta=0.2\text{nm}$, $L_c=1.1\text{nm}$ used; average over 50 samples
- Transverse k-direction for black phosphorus UTB → thicker structure used (6nm for 1L~3L; 3nm for 4L~7L; 2nm for 8L~10L)

Linear phonon dispersion is assumed

$$|U_q|^2 = \frac{\hbar D_{ac}^2}{2\rho v_s} q$$

For black phosphorus
 ρ material density 2.69 g/cm³

H Liu et al, Chem. Soc. Rev. 44, 2732 (2015)

D_{ac} deformation potential is thickness dependent
 Increase from 1L to 5L and saturate

J Qiao et al, Nature Comm. 5, 4475 (2014)

v_s sound velocity 3.8km/s armchair direction, 7.8km/s zigzag direction

Z Zhu et al, Phys. Rev. Lett. 112, 176802 (2014)

Self-energy due to acoustic phonon scattering (low energy, high temperature)

$$\Sigma(r_1, r_2, k, E) = \frac{D_{ac}^2 k_B T}{2\hbar \rho v_s^2} \delta(r_1, r_2) \int \frac{dk'}{2\pi} G(r_1, r_2, k', E)$$

$$(E - H - \Sigma - \Sigma_{S/D})G = 1$$

Self-consistent Born iteration

Lake et al, J. Appl. Phys. 81, 7845 (1997)